

LHC detectors



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Course on Physics at the LHC

LIP, 8th-10th March 2021

- From collision remnants to physics
- Connecting the dots: tracking
- Si-based detectors
- Calorimetry for pedestrians
- Getting data on tape: trigger systems

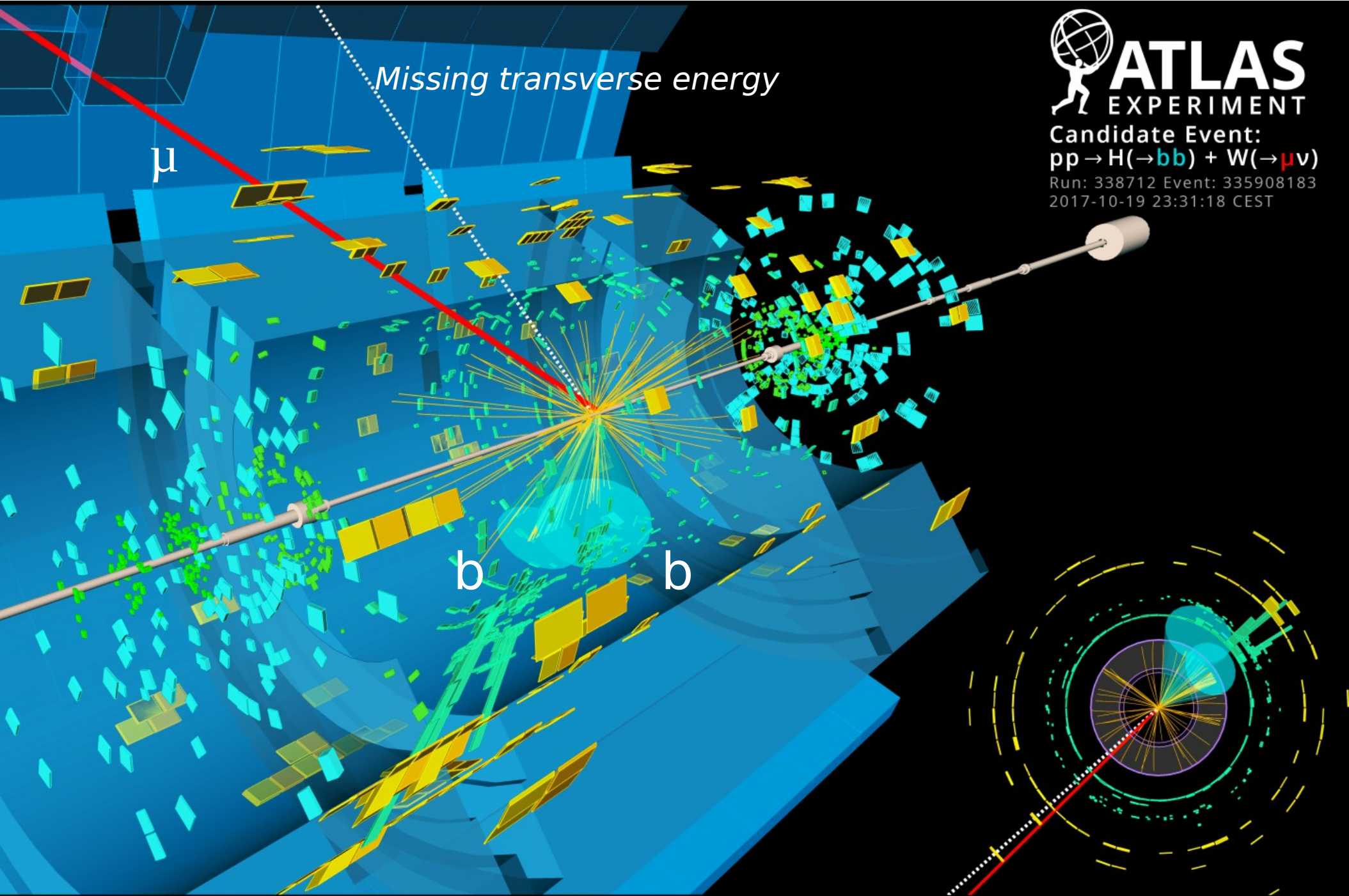
1st part

2nd part

**From
collision remnants
to
physics**

At the LHC the hunt for new physics has exciting signatures

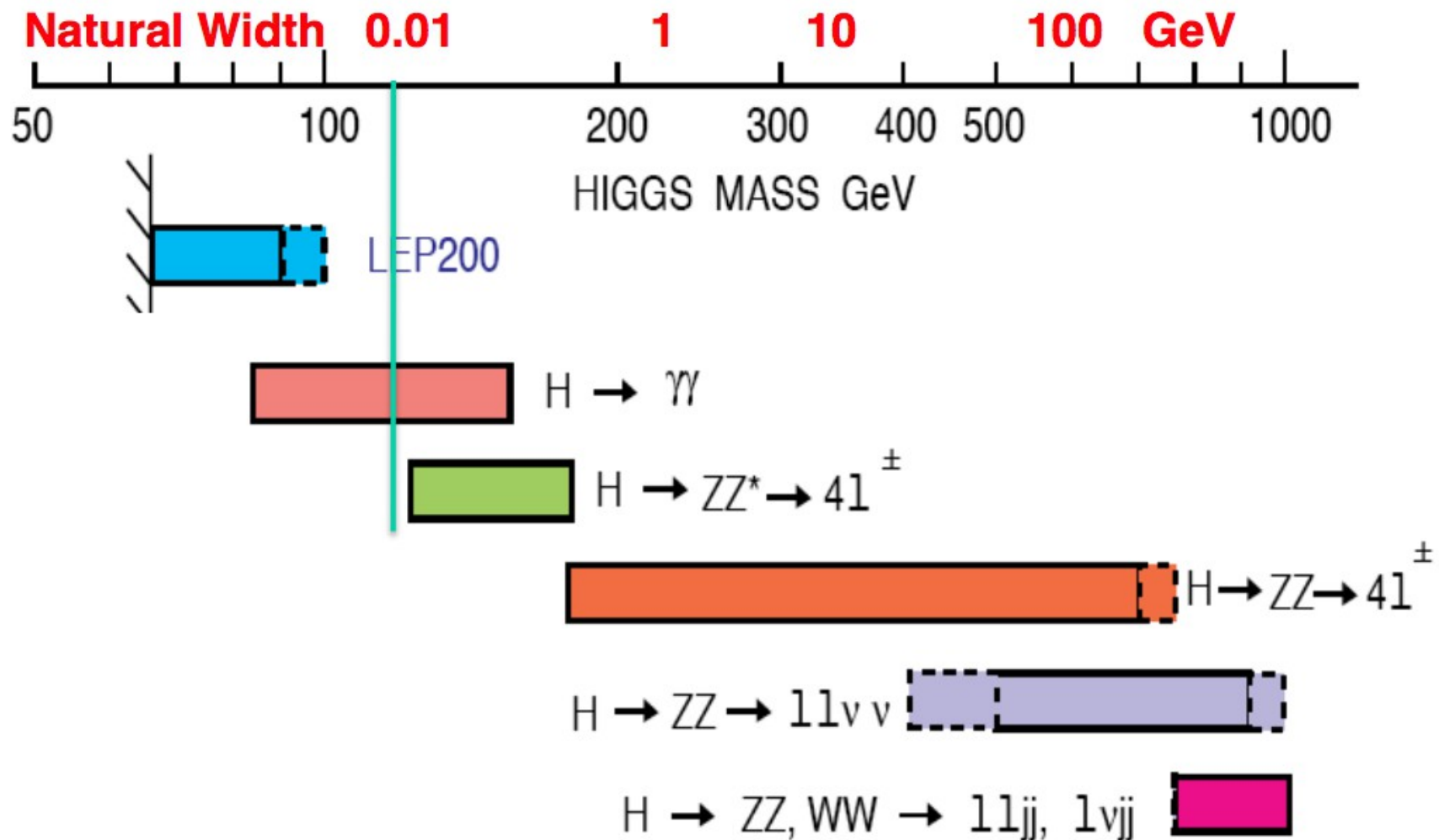
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Discovery drove the LHC detectors concept

Before the Higgs discovery different signatures were expected depending on m_H
4 π -hermetic general purpose detectors were needed

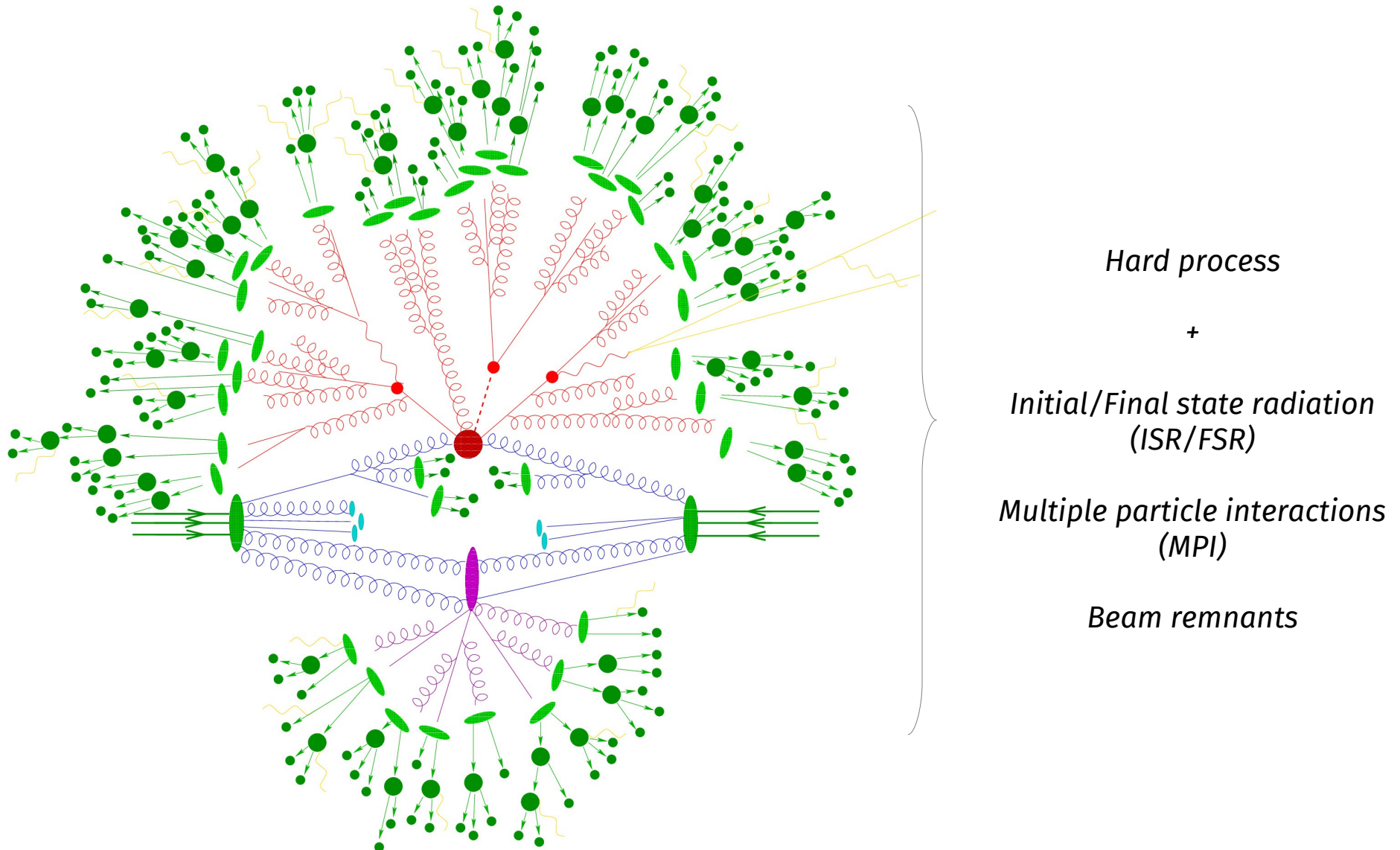
- covering: leptons, photons, jets, missing energy ...



Proton-remnants underlie the hard processes

A hadron collider scans a large energy range but yields an underlying event

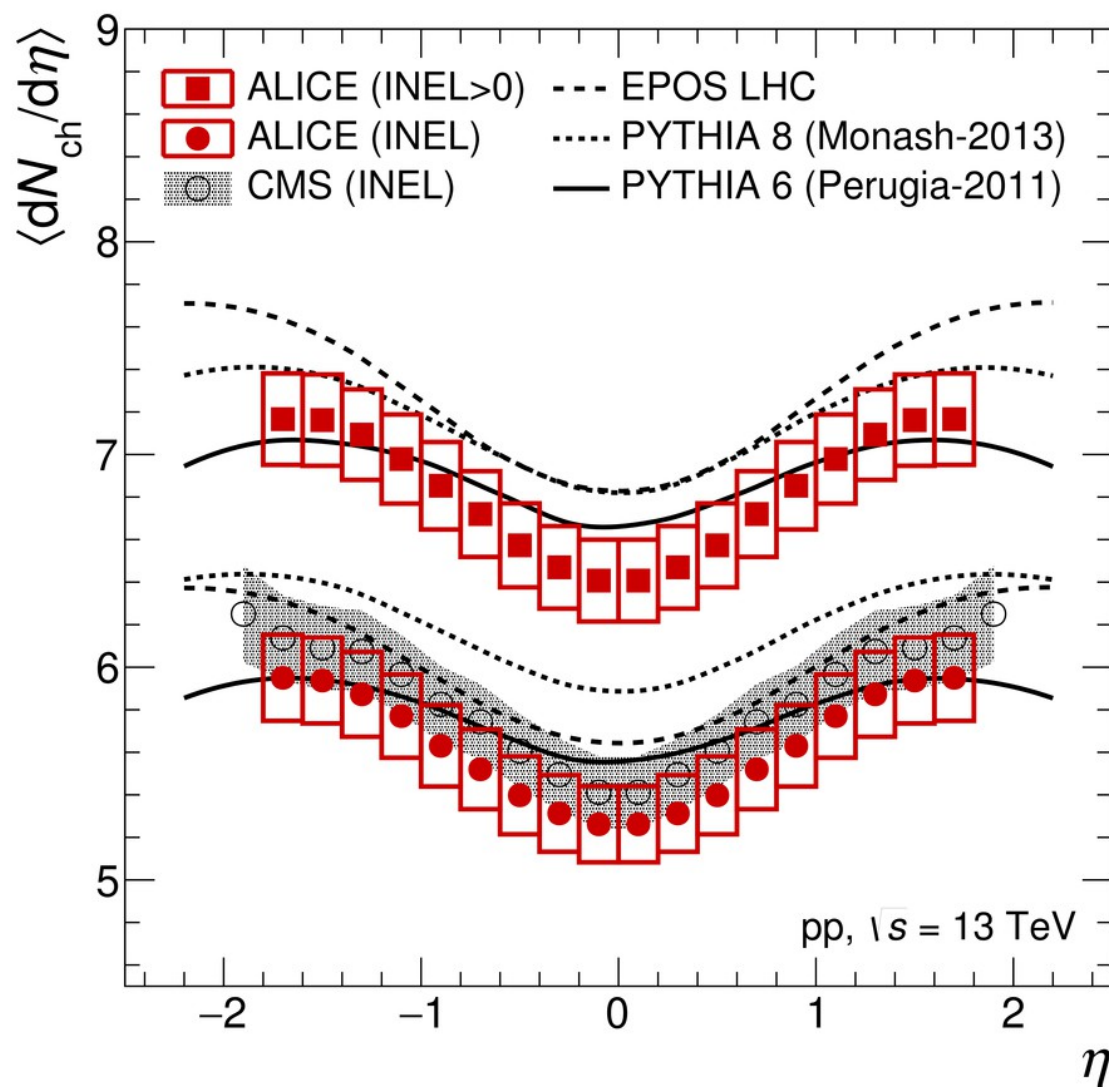
Single proton collisions produce high multiplicity events



Proton-remnants underlie the hard processes

A hadron collider scans a large energy range but yields an underlying event

Single proton collisions produce high multiplicity events (approx. uniform in η)



Average **15-20 charged particles** per inelastic collision

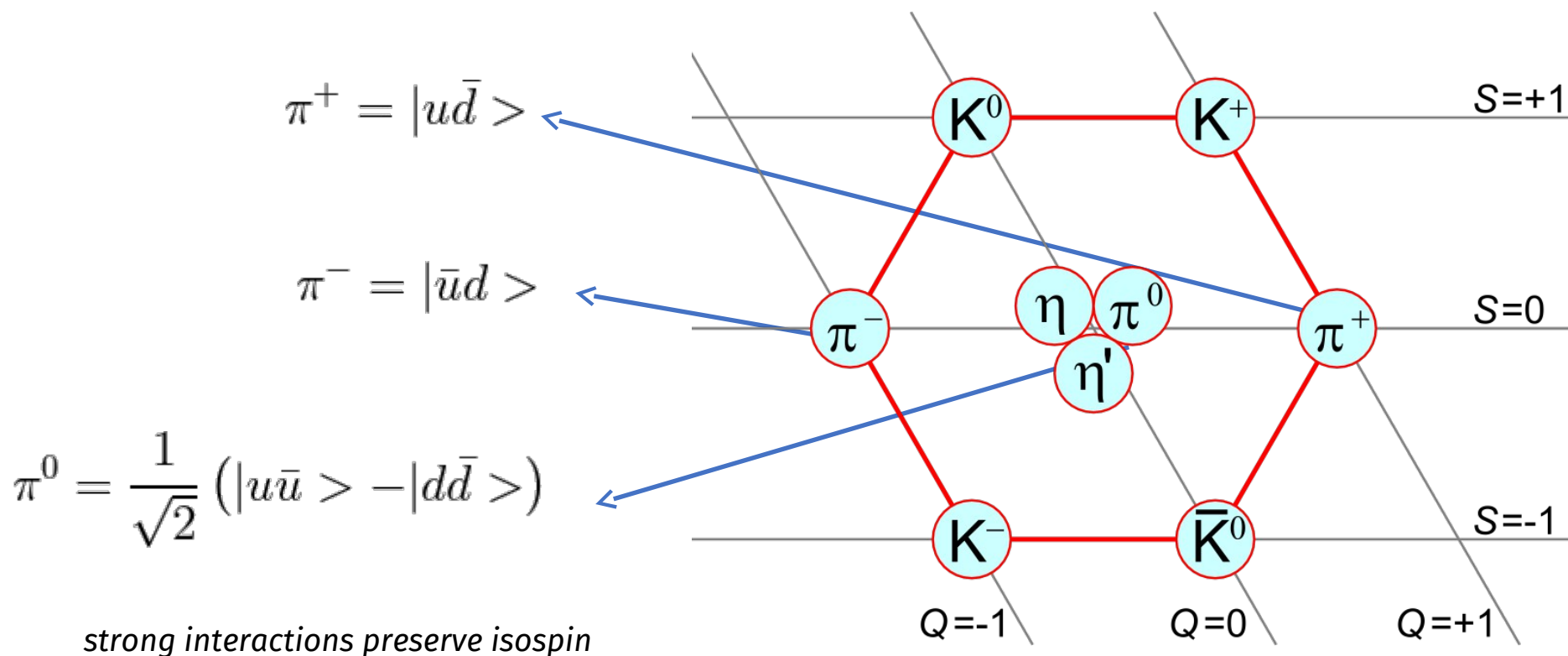
Proton-remnants underlie the hard processes

A hadron collider scans a large energy range but yields an underlying event

Single proton collisions produce high multiplicity events (approx. uniform in η)

Most particles are pions with

$$N(\pi^0) \approx \frac{1}{2}N(\pi^\pm)$$



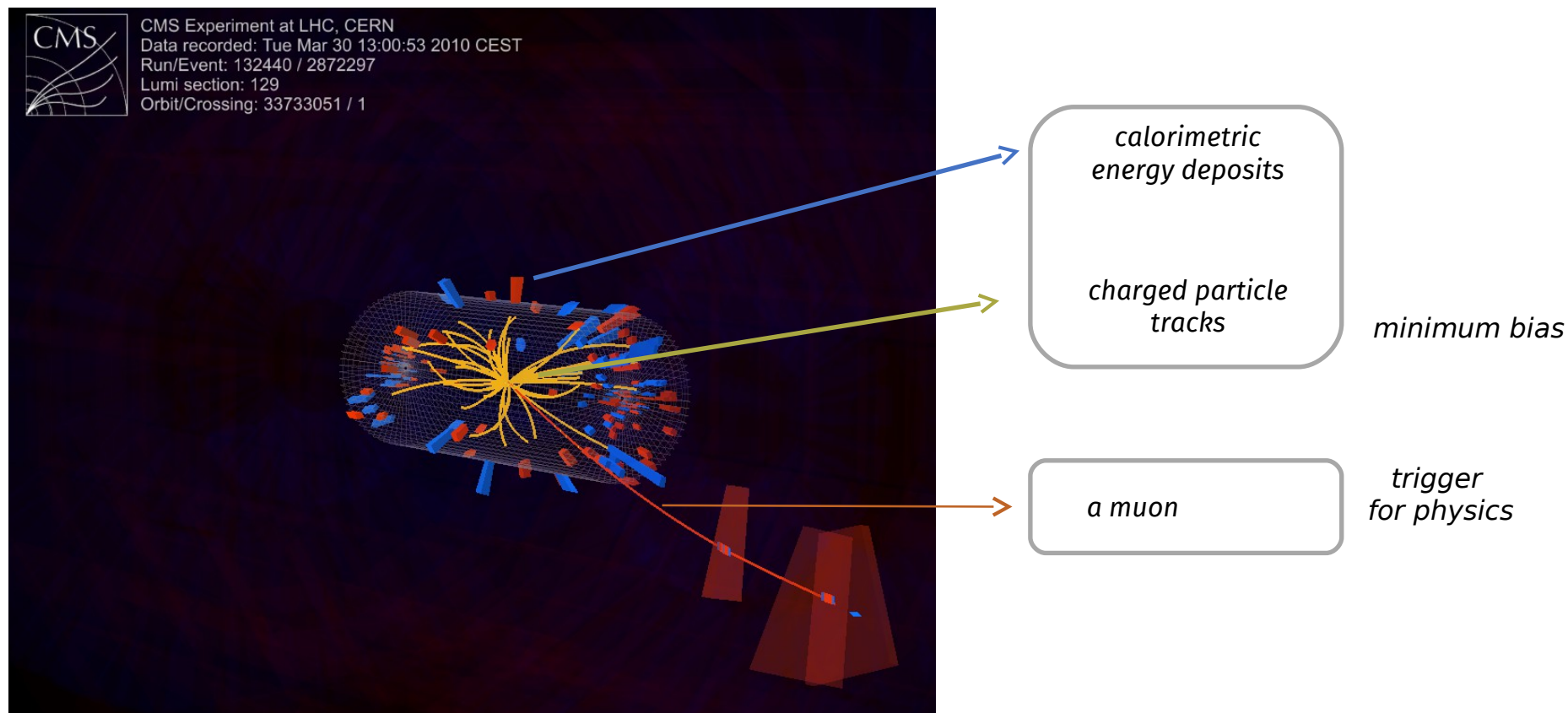
Proton-remnants underlie the hard processes

A hadron collider scans a large energy range but yields an underlying event

Single proton collisions produce high multiplicity events (approx. uniform in η)

Most particles are pions with
$$N(\pi^0) \approx \frac{1}{2}N(\pi^\pm)$$

As $BR(\pi^0 \rightarrow \gamma\gamma)=99\%$ we expect approx. the same number of photons and π^\pm

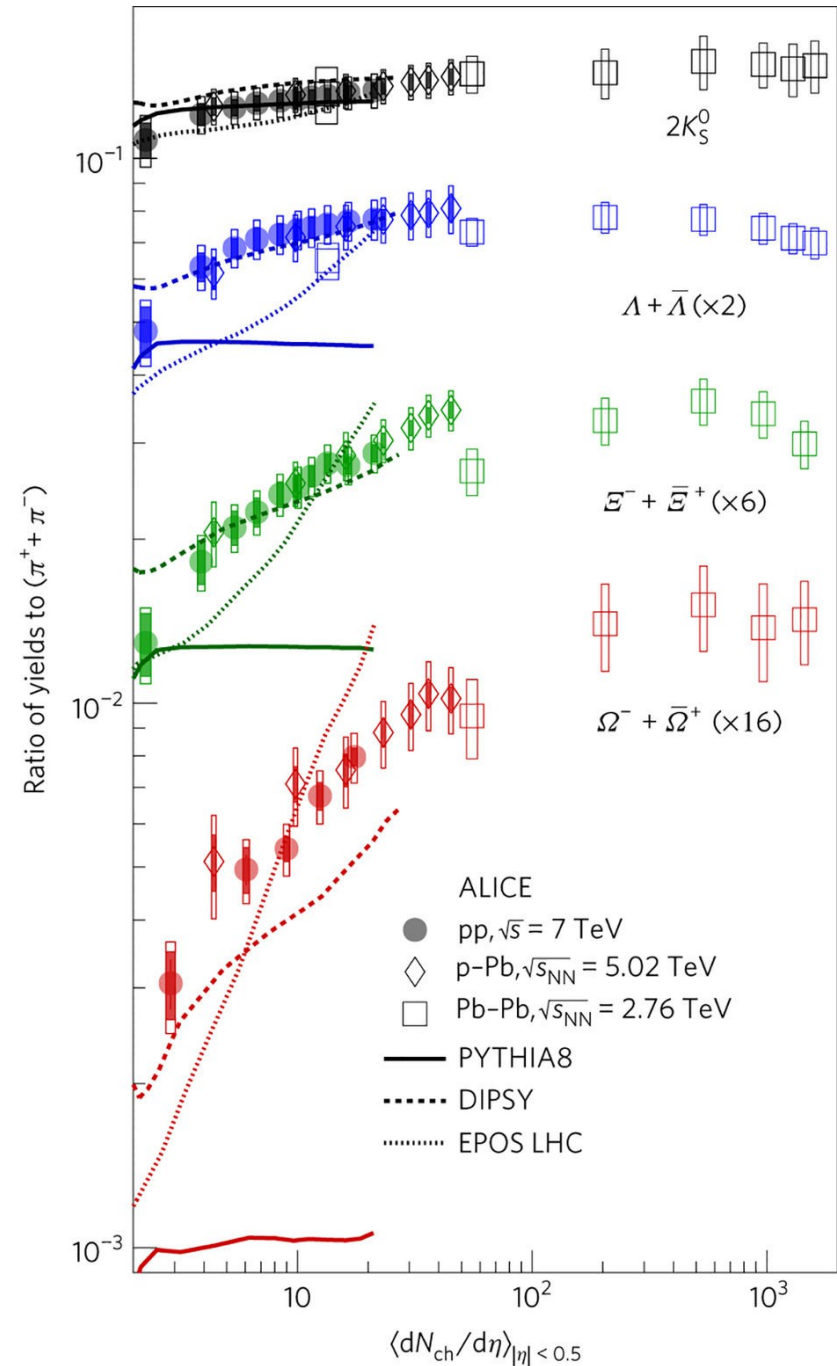


Beyond pions and photons

Production of other particles suppressed by

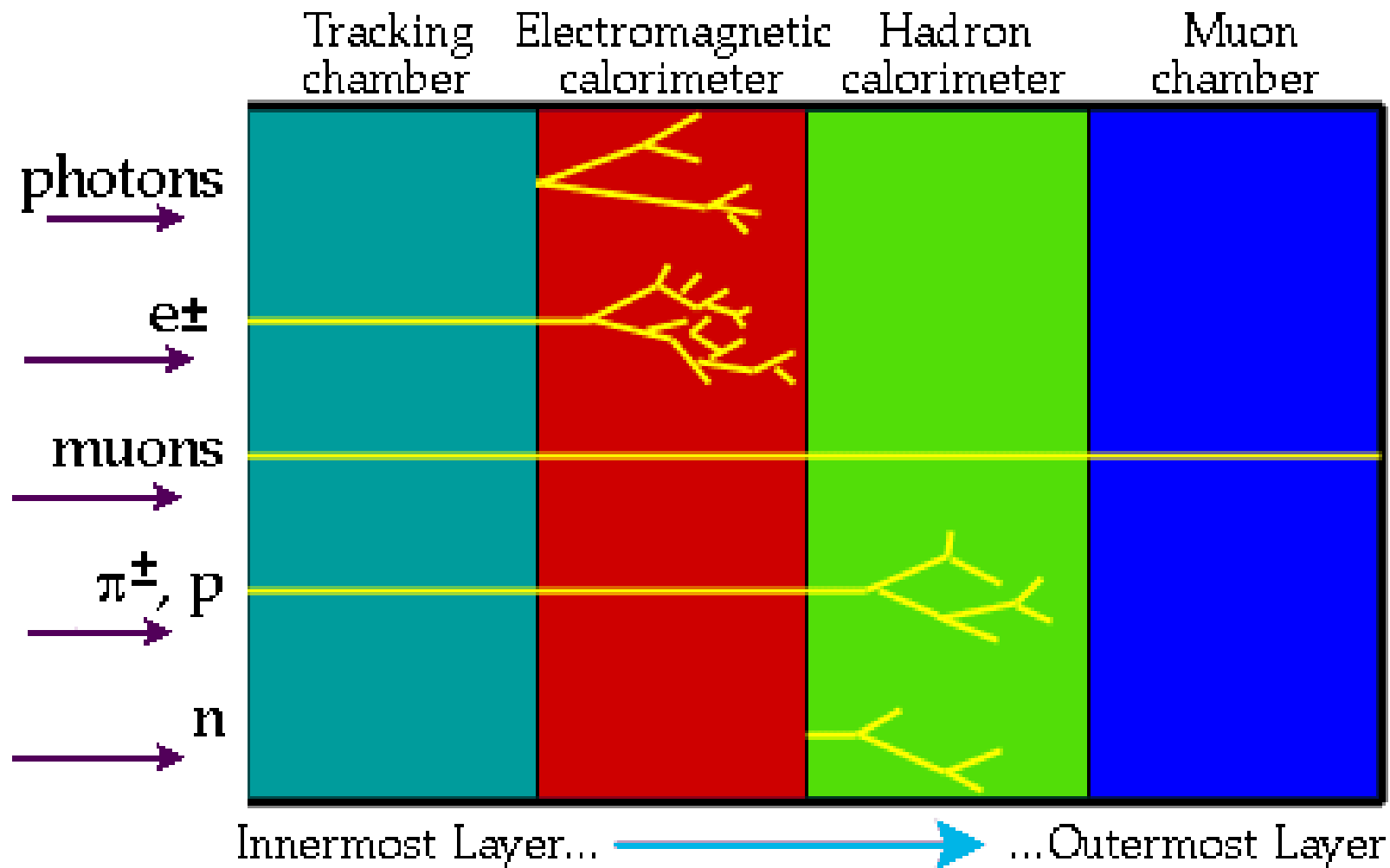
- content of the proton (PDFs)
- mass ($m_s \sim 19m_d$)

Particles with strangeness end up accounting for $O(10\%)$ of the multiplicities



Particles and their interactions

12

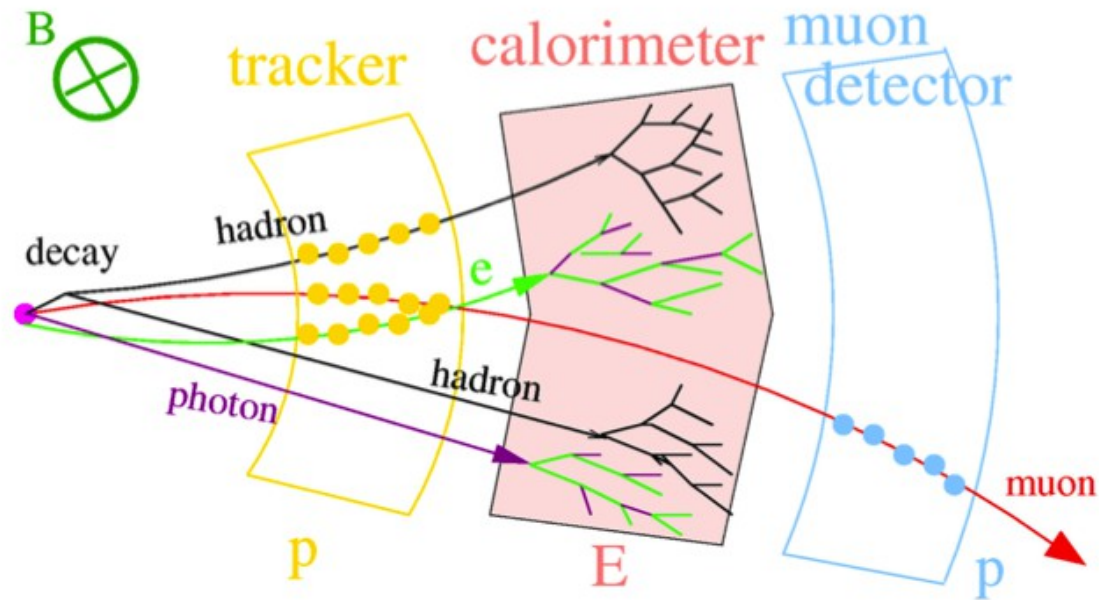


Detectors register the passage of particle through matter – how ?

Absorbers (force interactions) + sensitive materials (convert charge/light to voltage)

Main concepts behind general purpose detectors

13



Magnetic field “ $F_c = qvB$ ”

- separate by charge
- measure p by curvature

Calorimetry

- measure E from deposits
- electromagnetic and hadronic

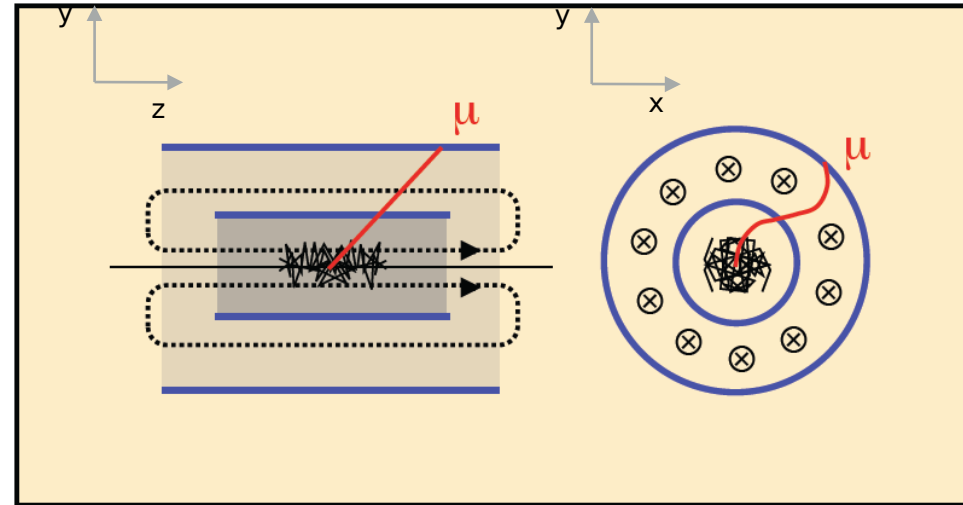
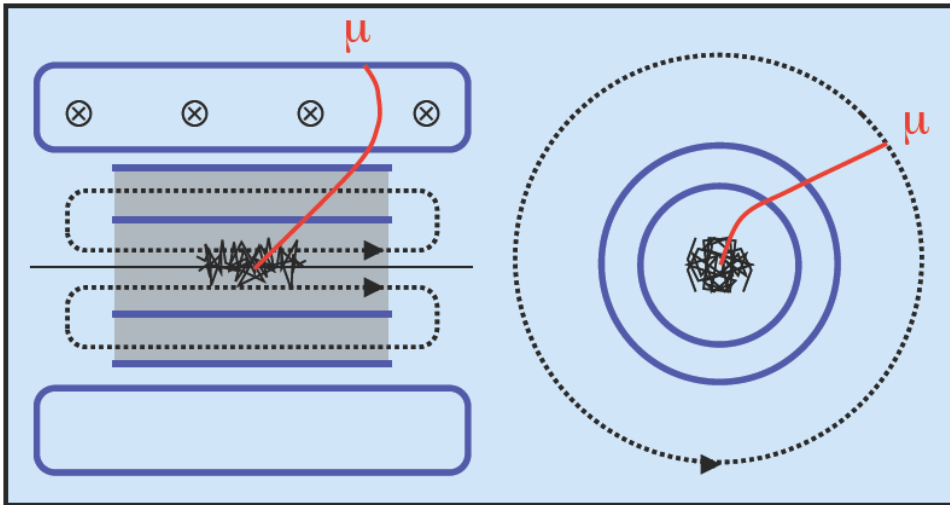
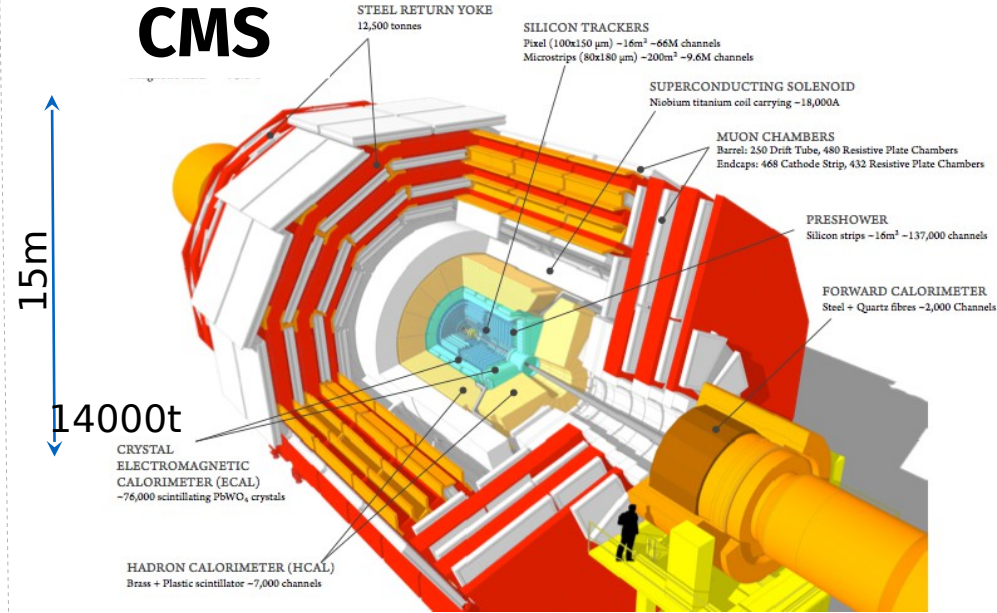
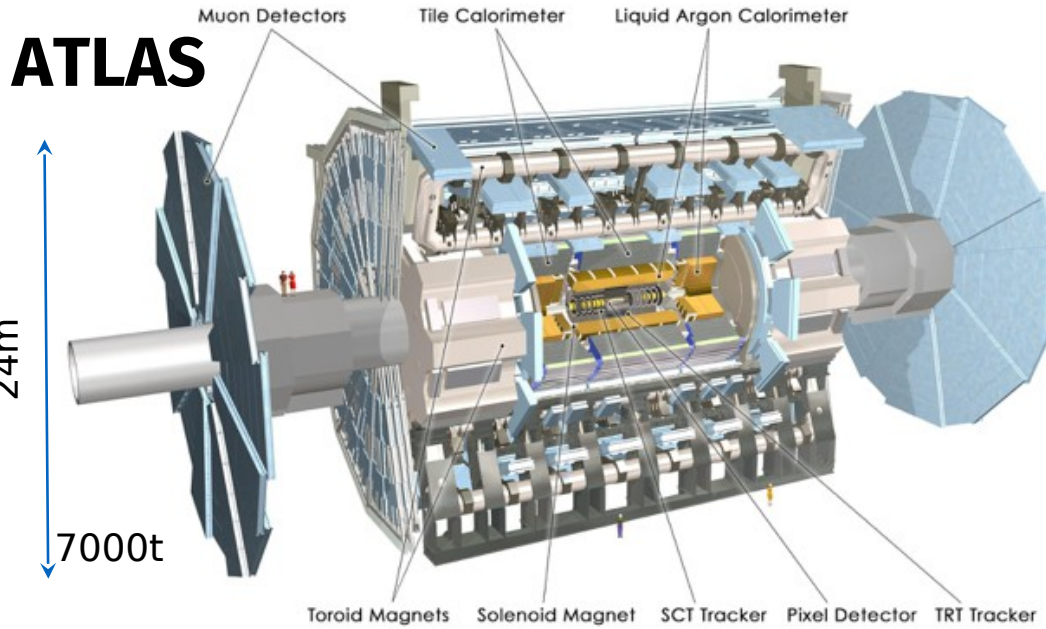
Inner tracking

- minimal interference with event
- points to measure curved tracks
- particle identification

Outer tracking

- muons (weakly interacting)

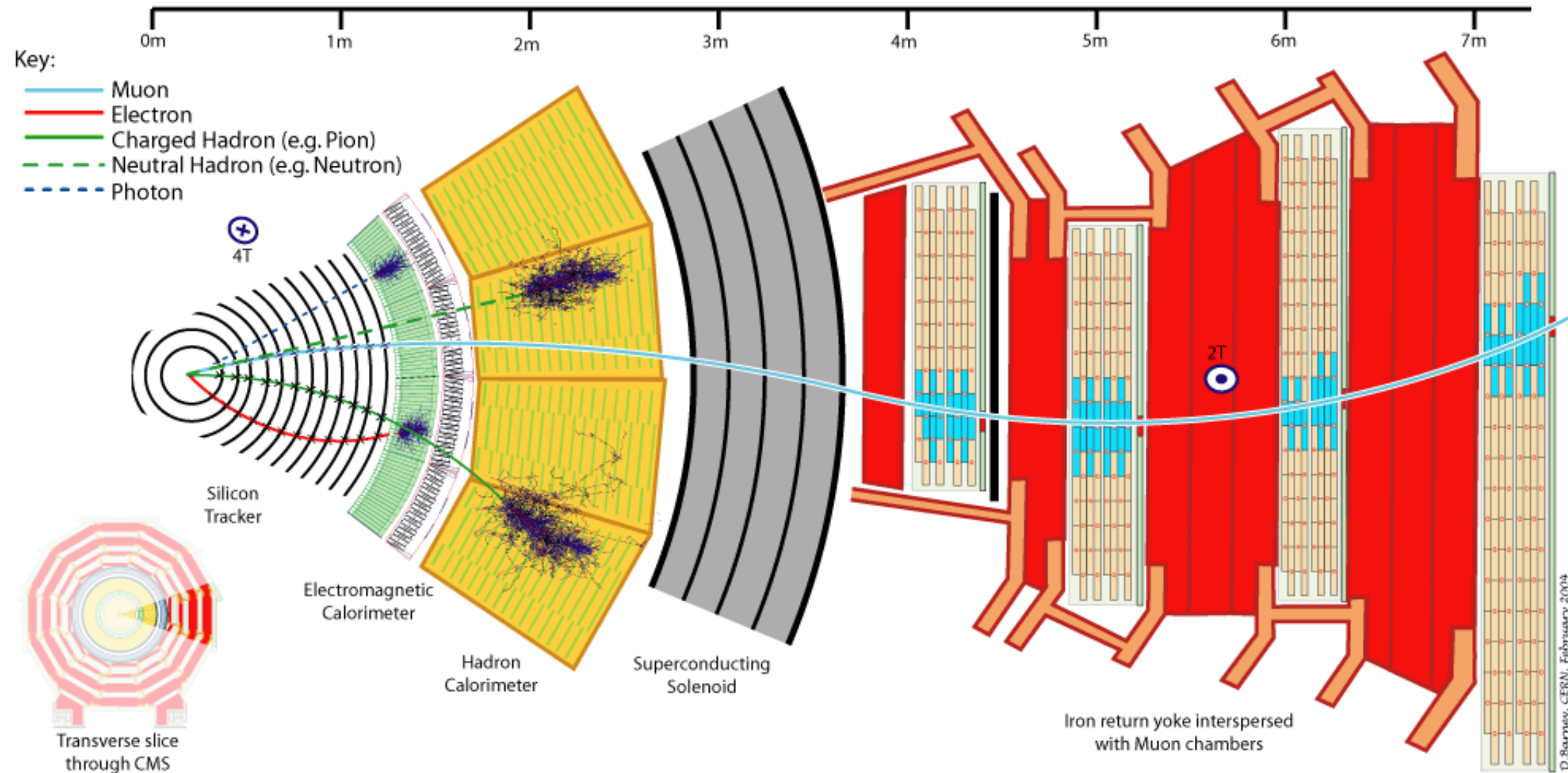
The two general purpose detectors



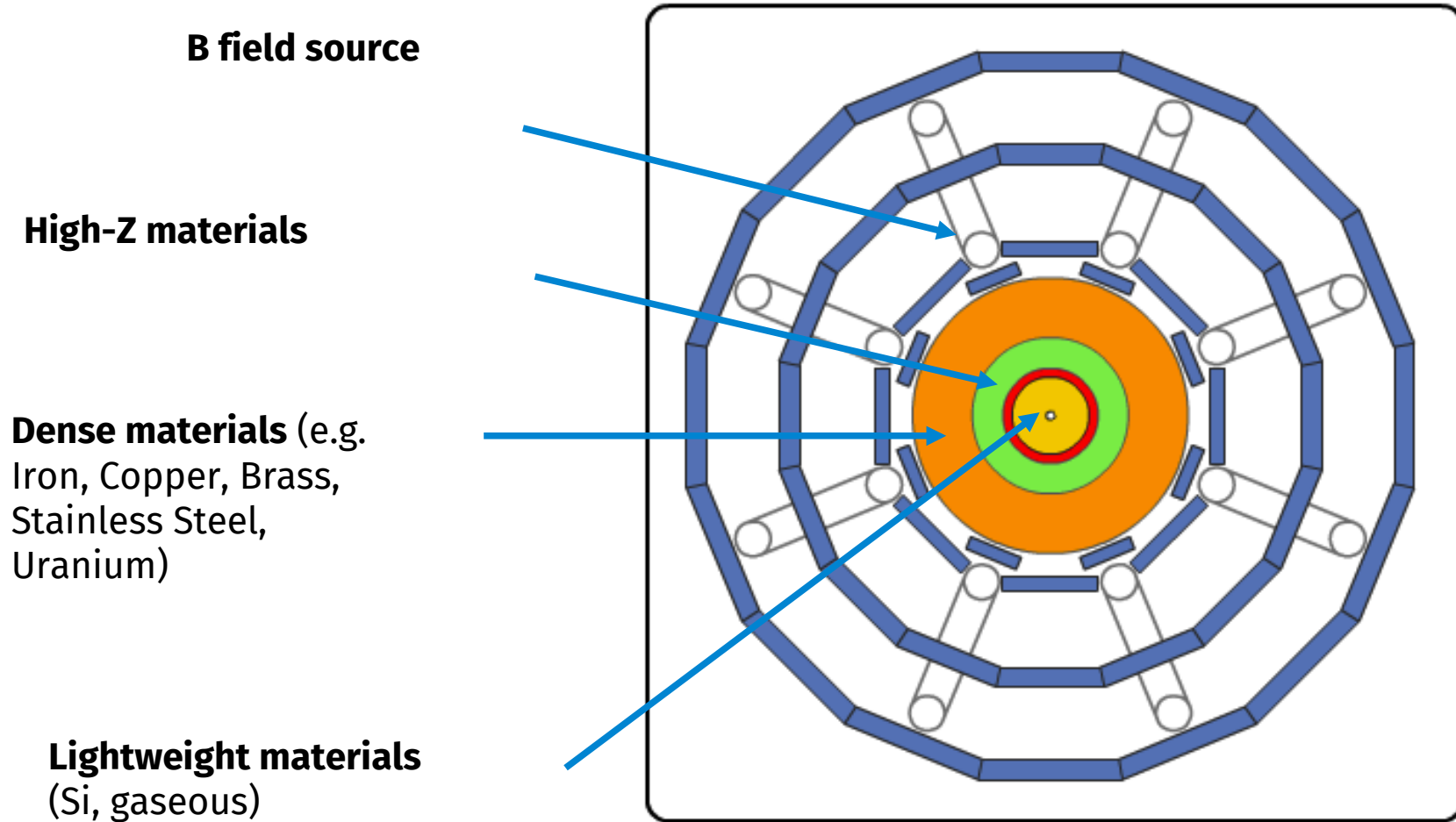
- Standalone measurement of $p(\mu)$
- Resolution is flat in η and independent of pileup

- Two complementary $p(\mu)$ measurements
 - Tracks point to primary vertex

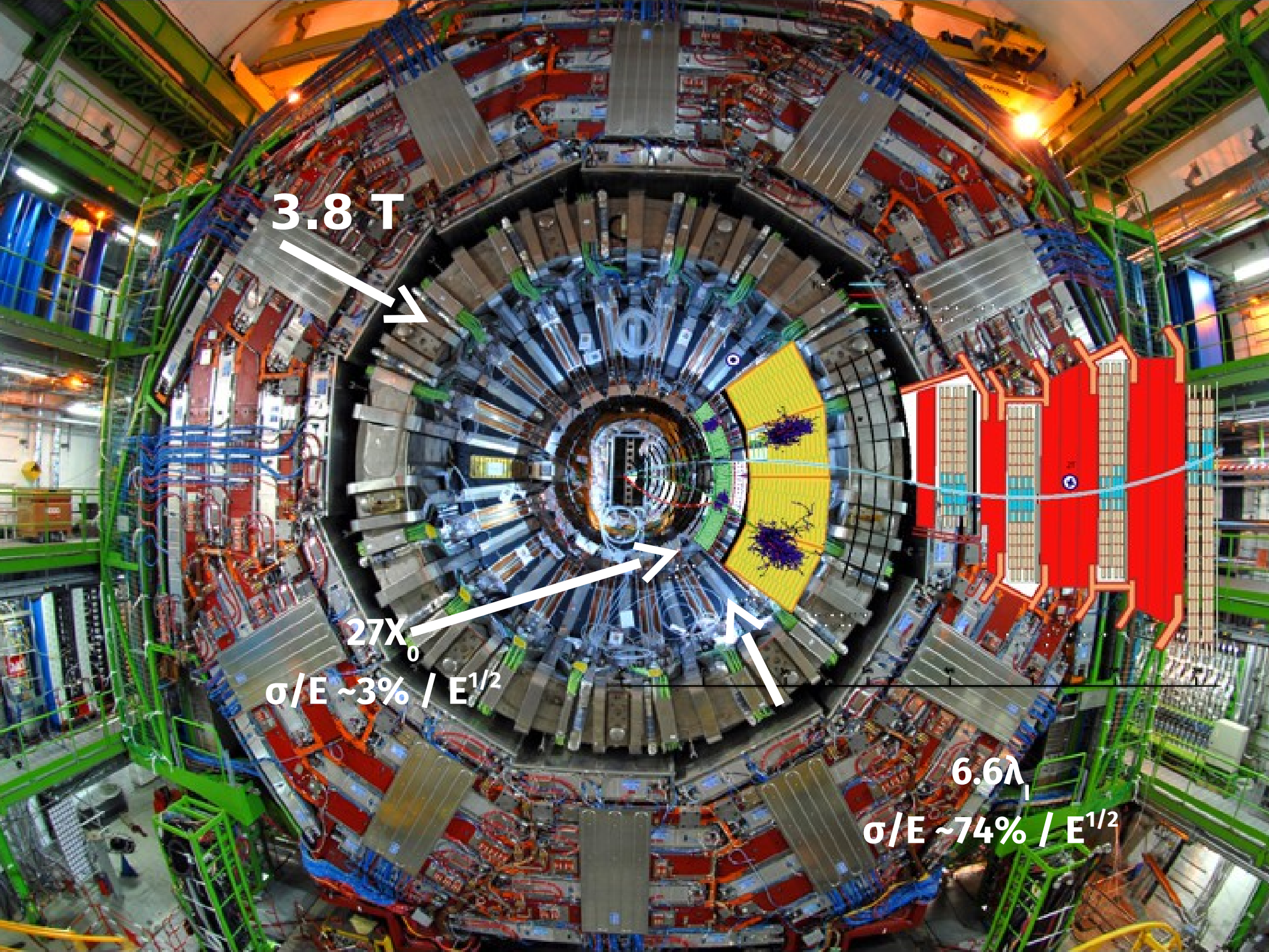
Particles and their interactions



Material distribution in general purpose detectors



*it's a challenge to fit it all within volume
trade-off between best energy resolution and particle identification*



3.8 T

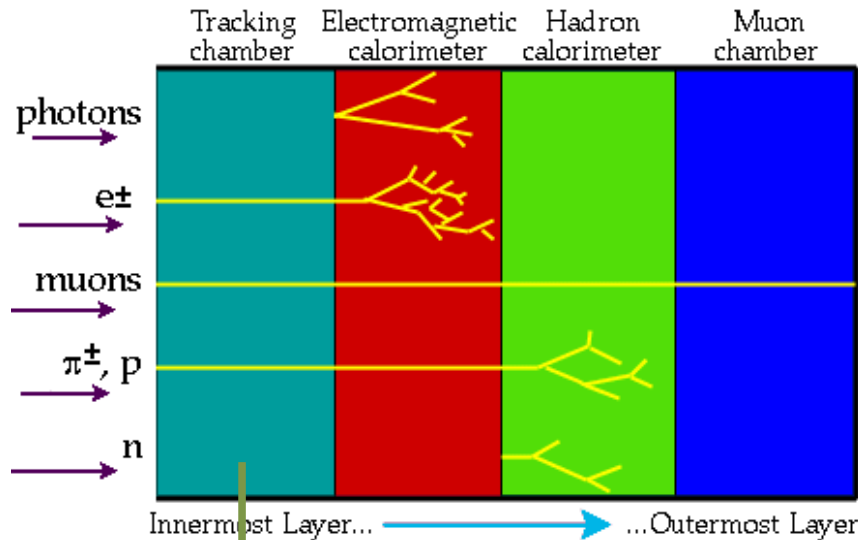
$27X_0$

$\sigma/E \sim 3\% / E^{1/2}$

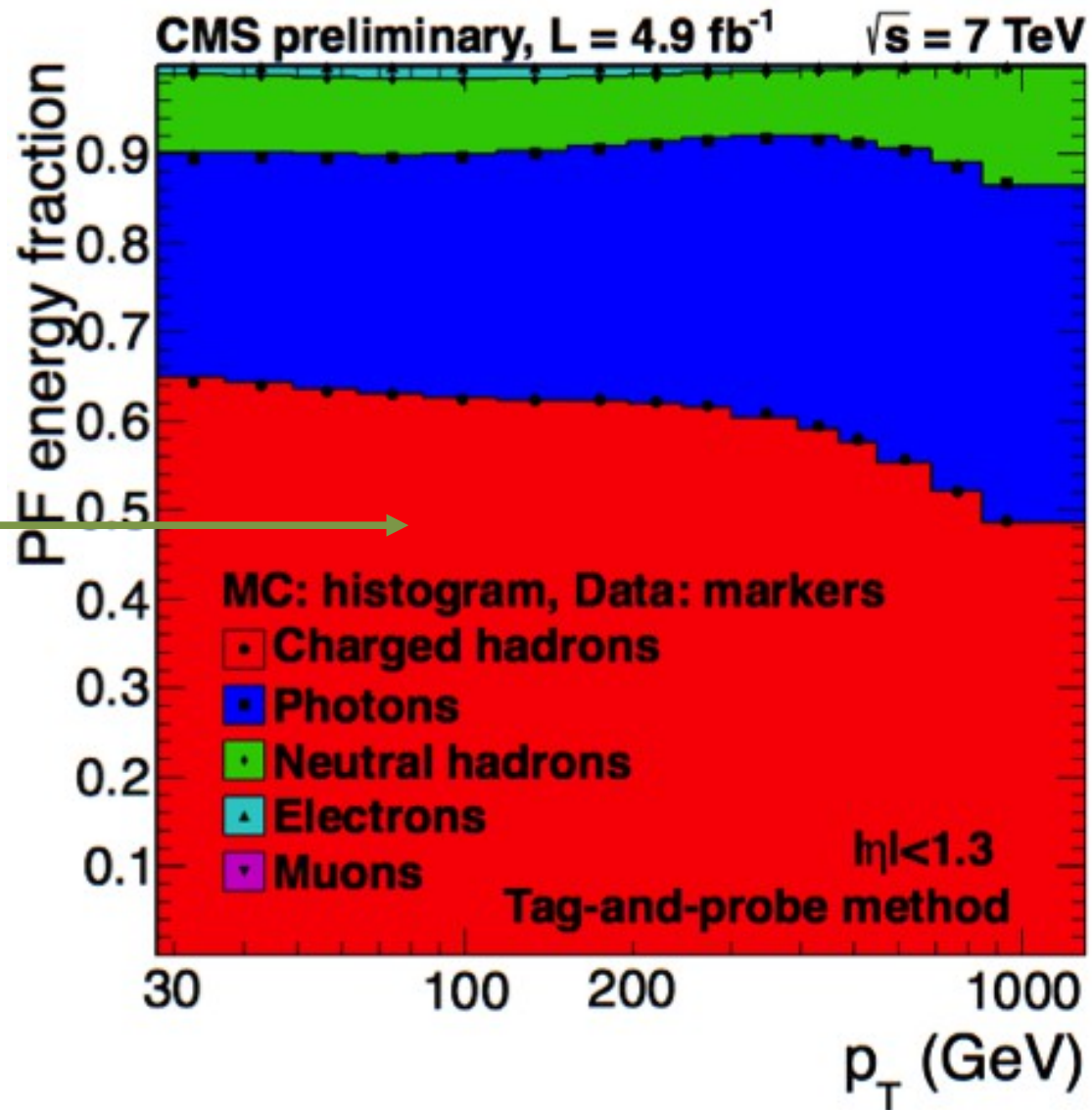
6.6λ

$\sigma/E \sim 74\% / E^{1/2}$

Particle flow



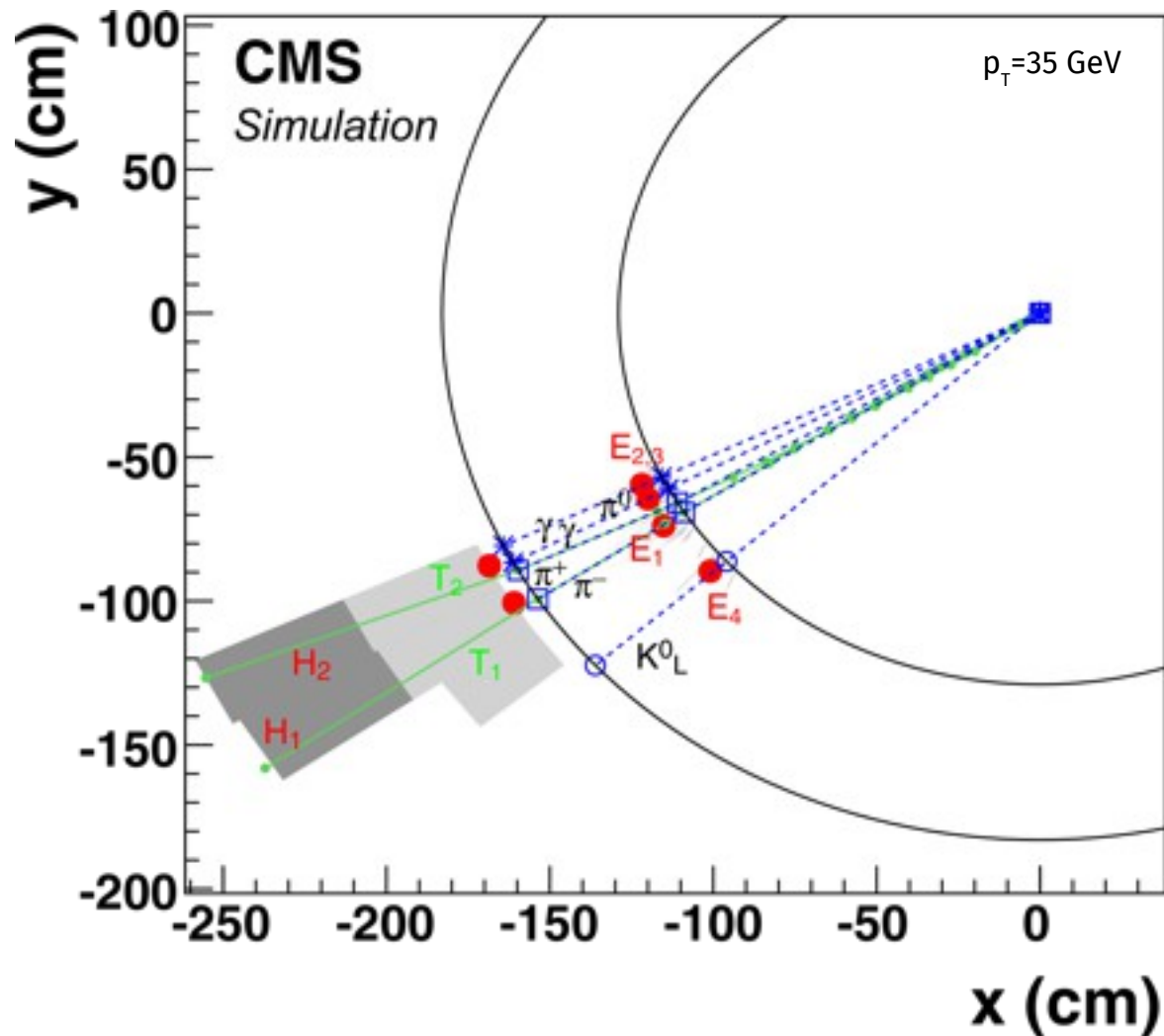
>60% of the energy of a jet may be reconstructed at the level of the tracker



Example: a jet of 5 particles

Reconstruction starts in the tracker

- Start from well reconstructed tracks, use remaining hits for others
- but that accounts only for 2/3 particles in this jet

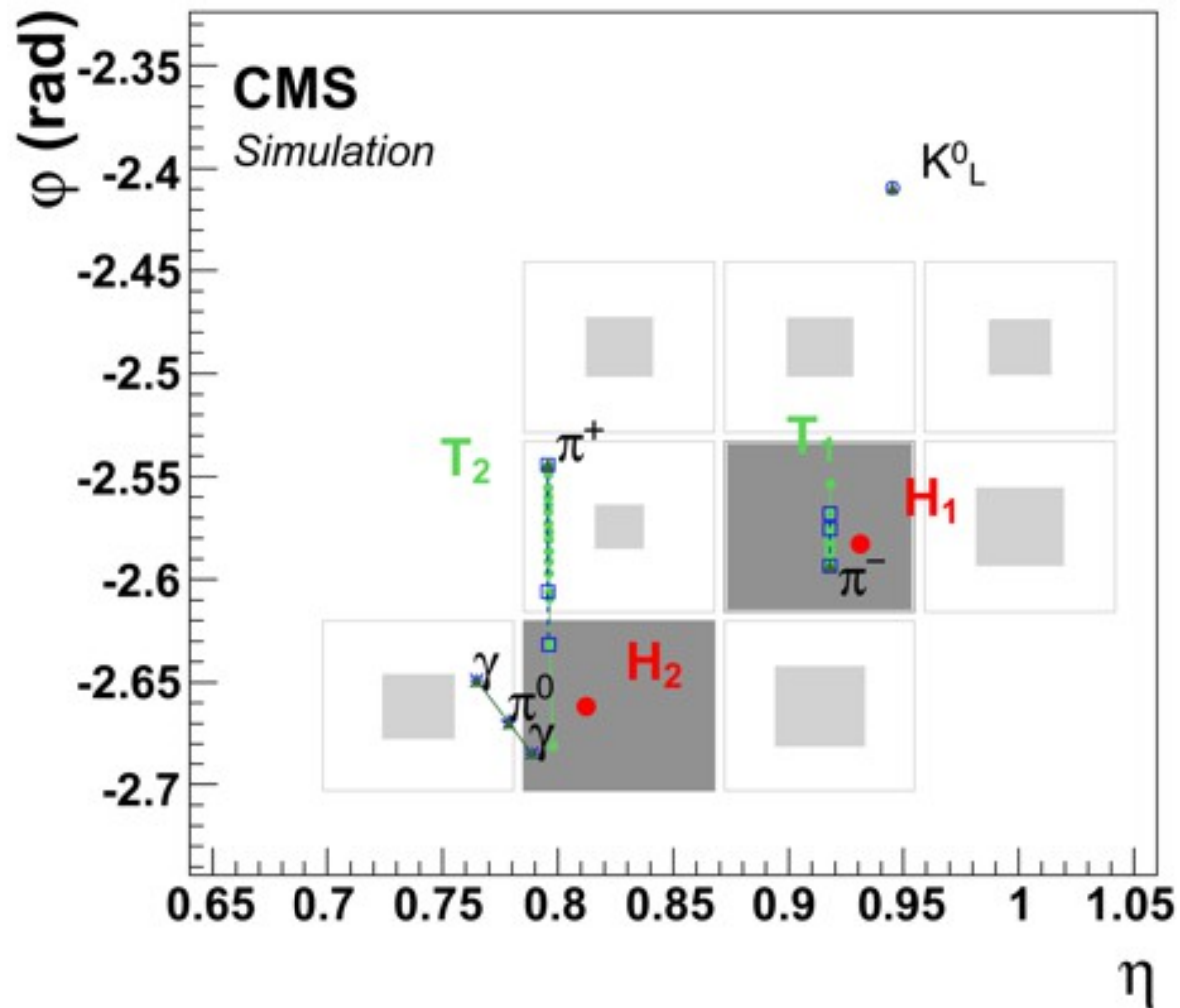


Example: a jet of 5 particles

Coarse granularity in the calorimeters (here hadronic)

Find local energy maxima and connect to neighbors

Determine energy sharing iteratively balancing with tracks

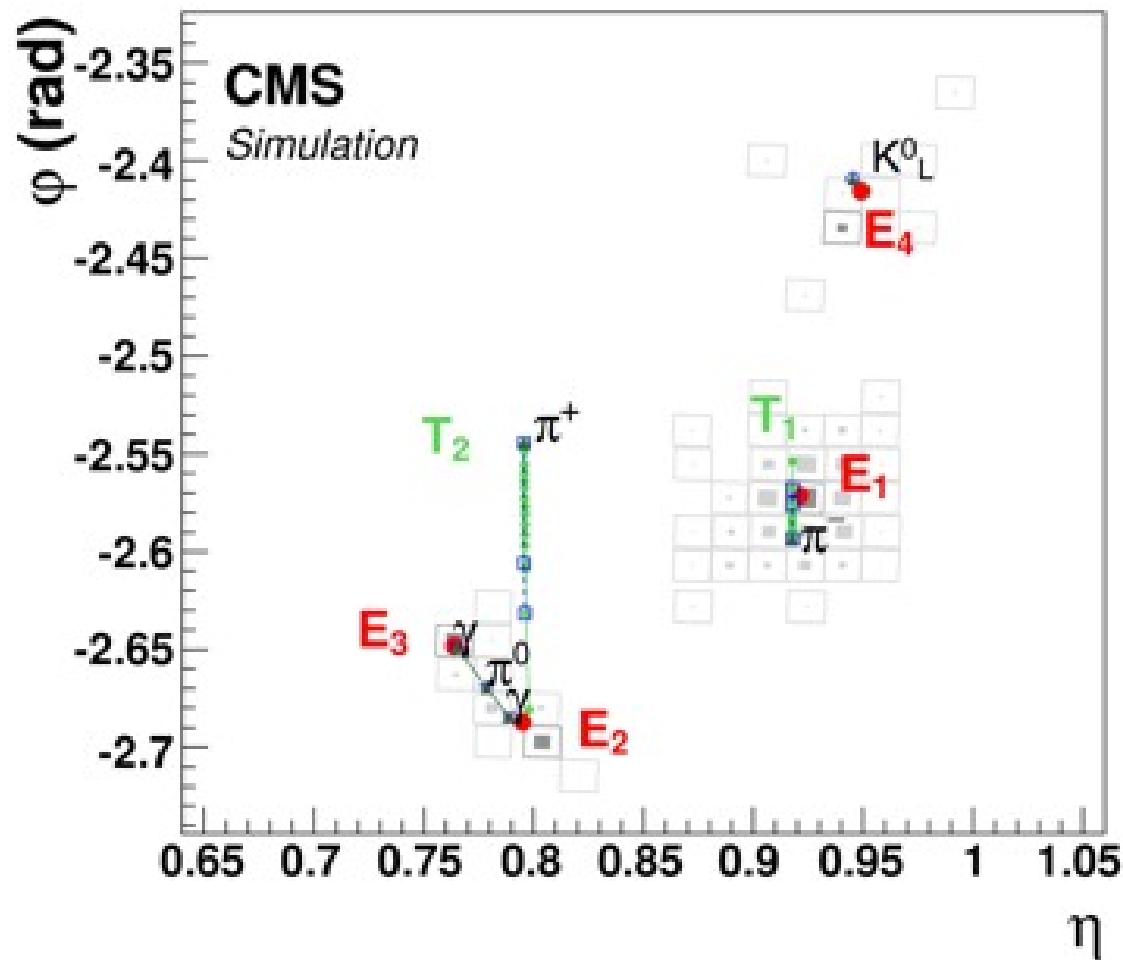


Example: a jet of 5 particles

The electromagnetic calorimeter makes finer measurements ($\Delta\phi, \Delta\eta \sim 0.02$)

Use to refine entry point in calorimeter, link to tracks and balance energy

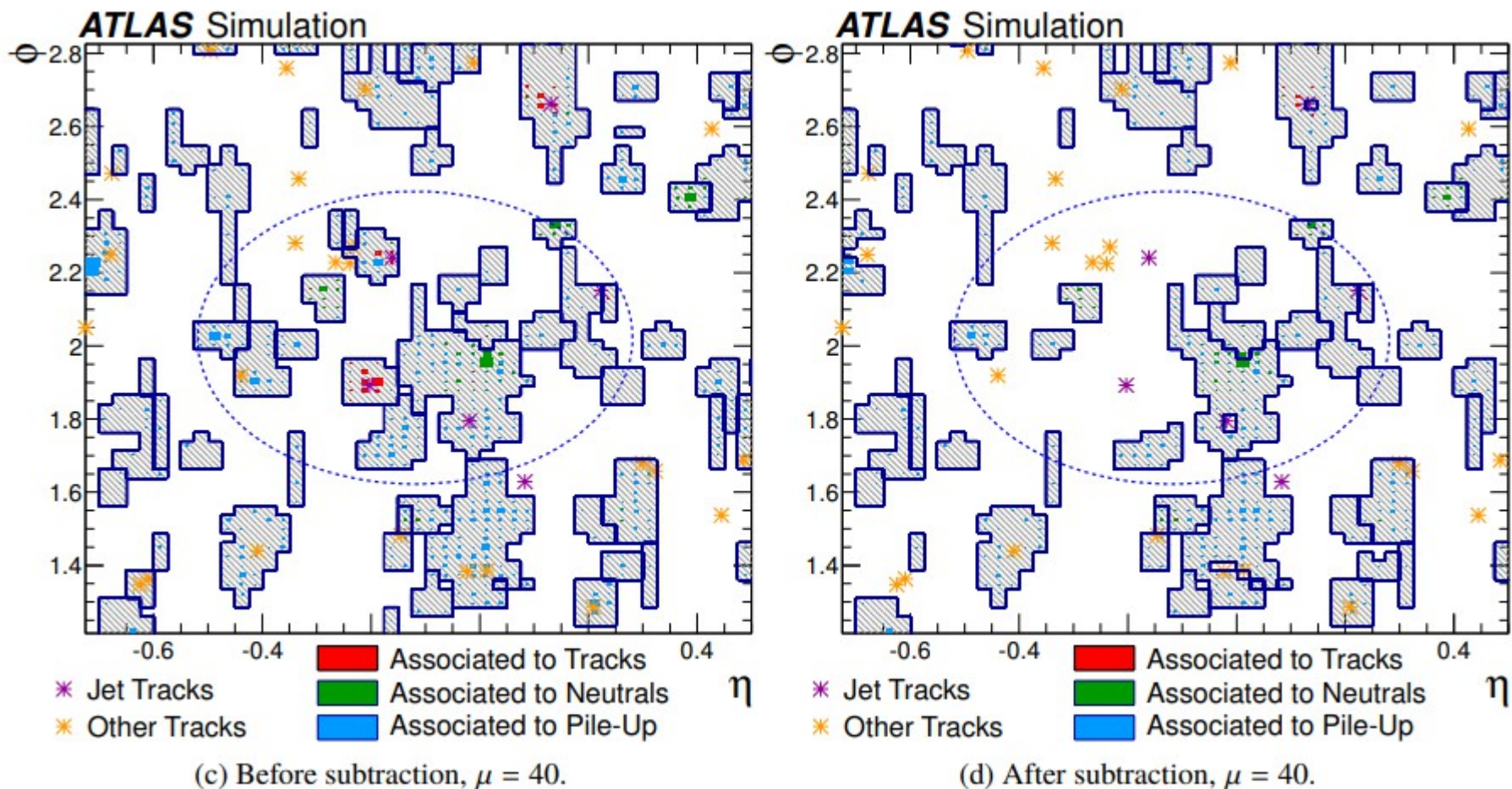
If energy can't be tracks \Rightarrow create photons and neutral hadron candidates



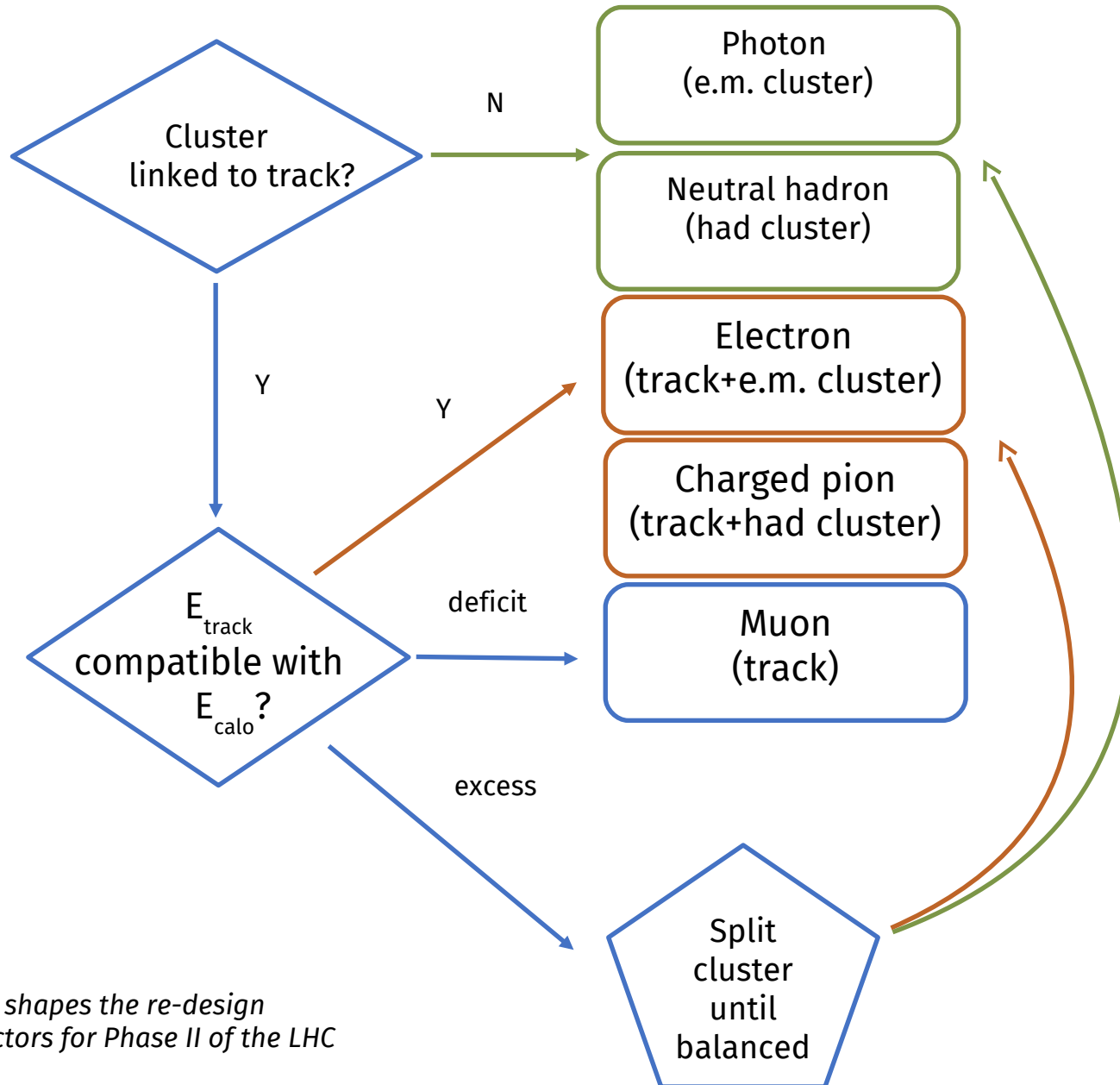
Example with pileup

Noise, pileup complicates the procedure and particle flow may benefit from cleaning

- Using tracks associated only to the primary vertex
- Removing calorimetric energy deposits/clusters compatible with noise/pileup

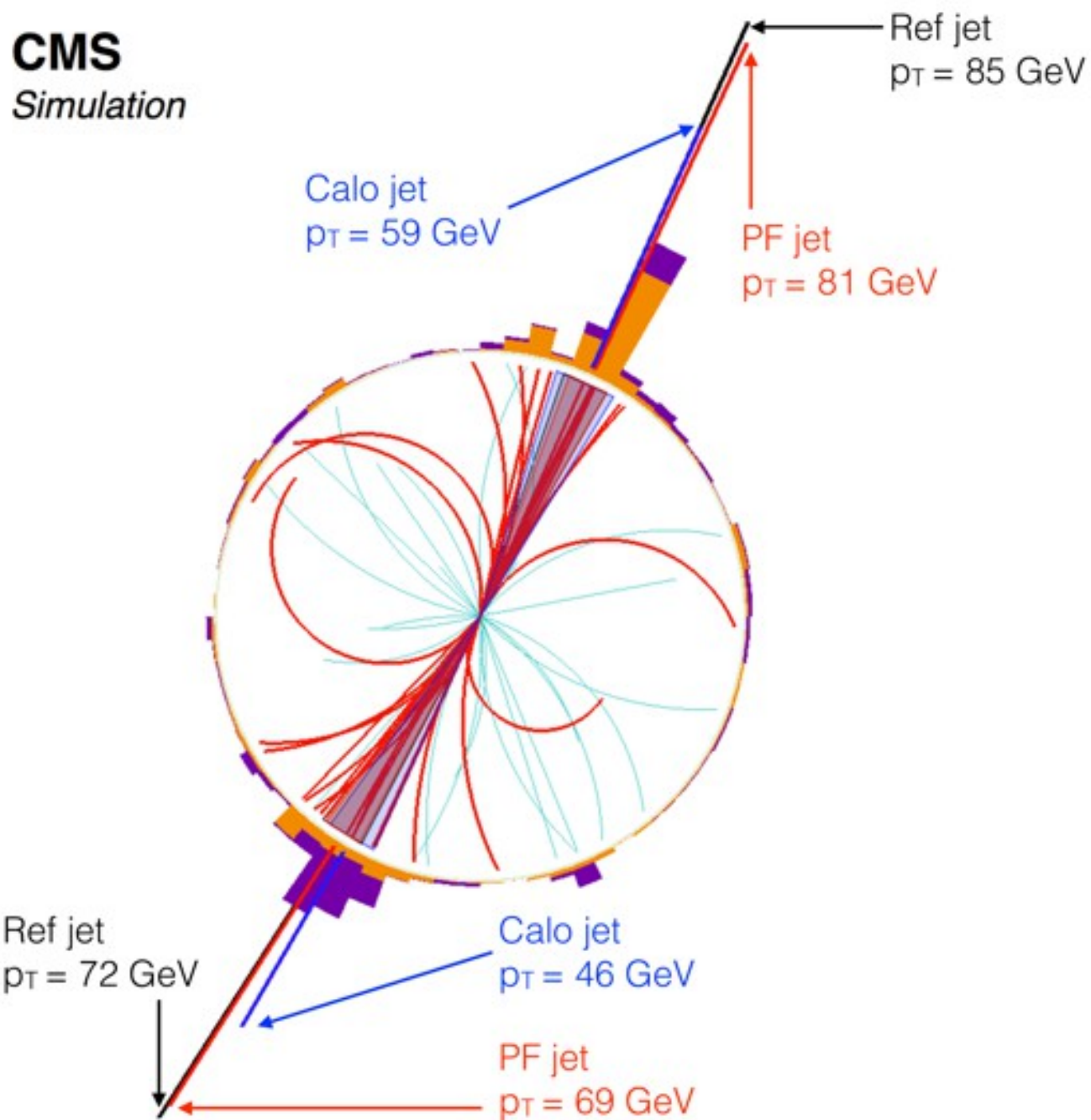


Particle flow algorithm is a reconstruction paradigm



it also shapes the re-design of the detectors for Phase II of the LHC

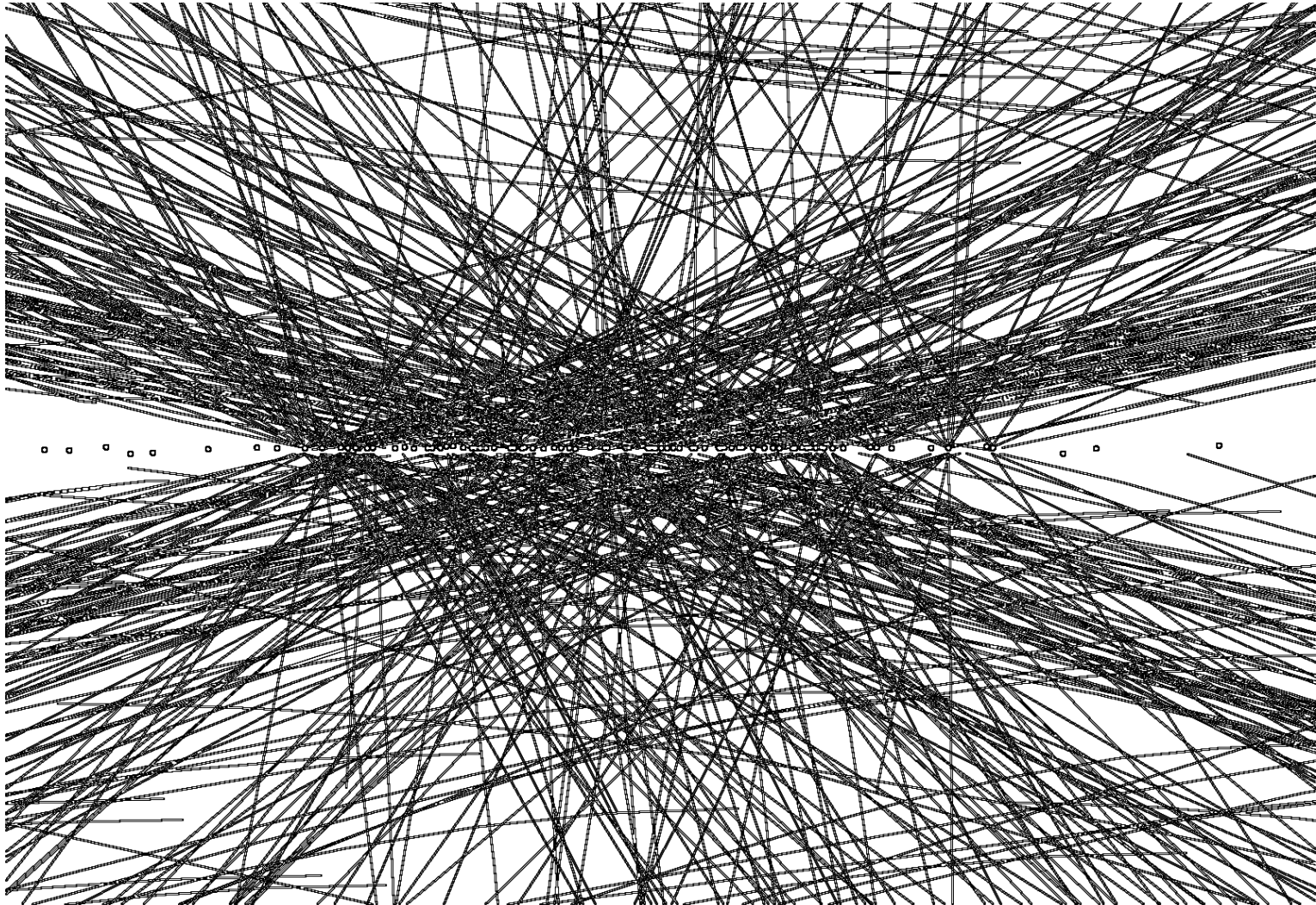
Particle flow algorithm is a reconstruction paradigm



Connecting the dots: tracking

Why?

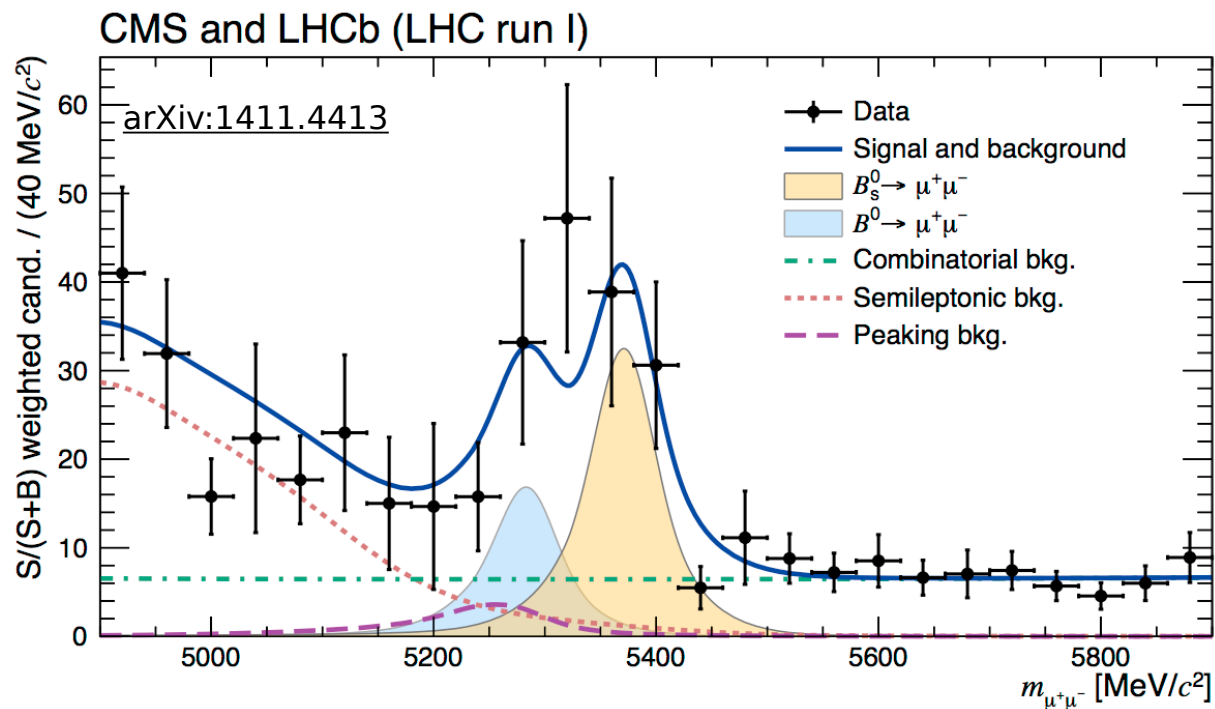
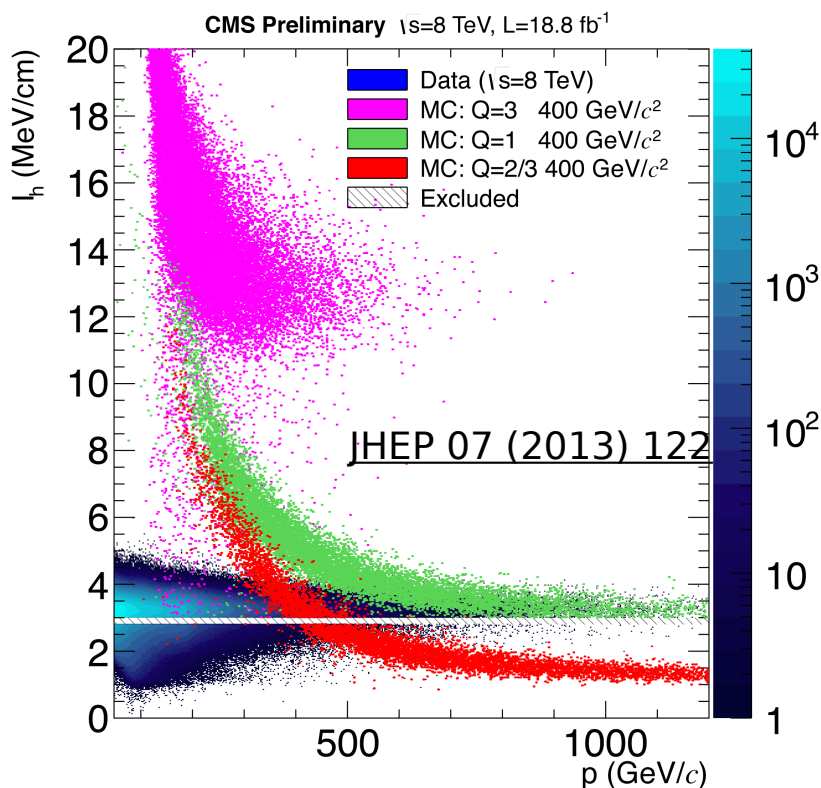
- Identify the vertex from the hard interaction
...but also secondary vertices from long lived particles



Why?

- Identify the vertex from the hard interaction
...but also secondary vertices from long lived particles
- Measure particle trajectories

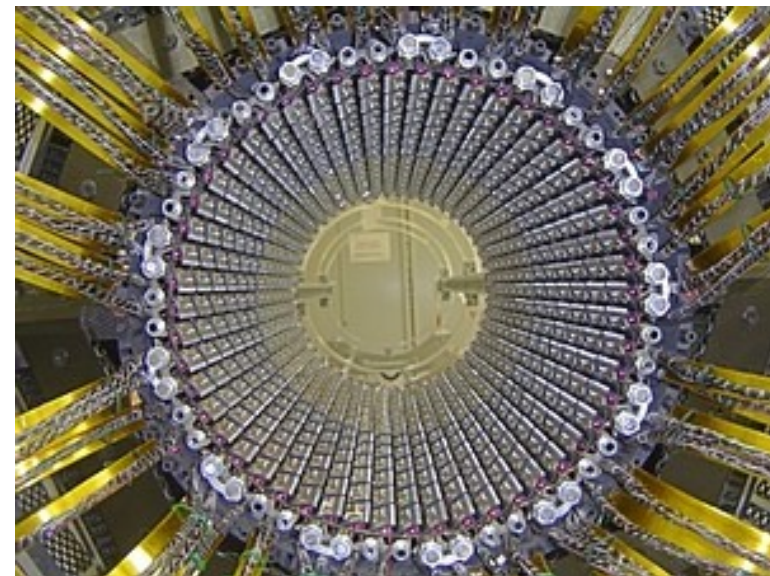
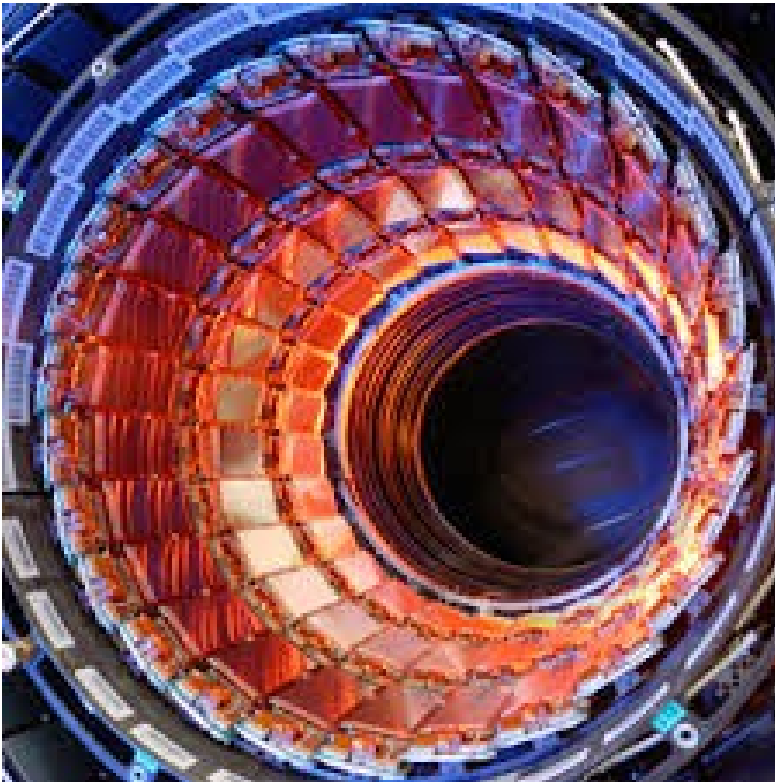
momentum (p), energy loss (dE/dx), link to coarser calorimeters and muon chambers



With what?

Solid state detectors

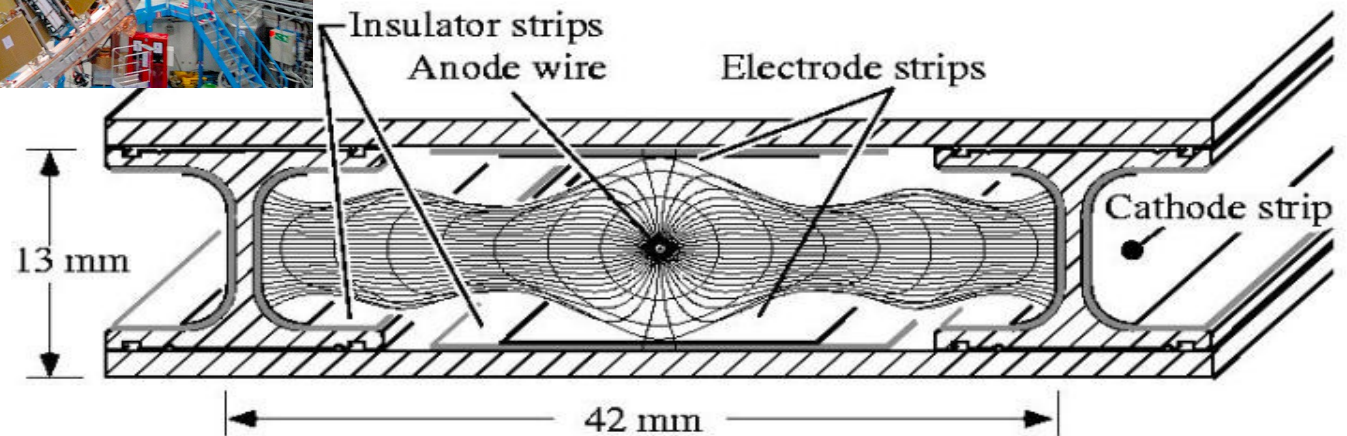
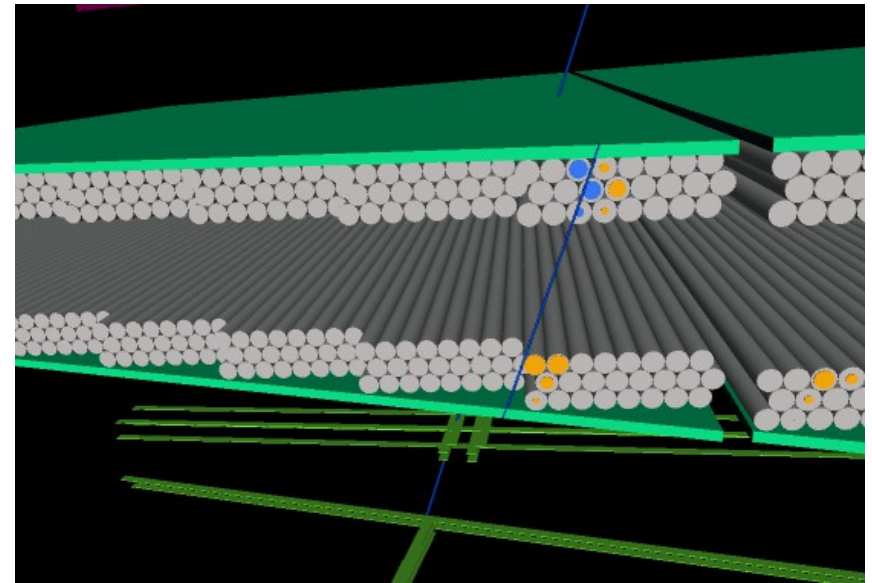
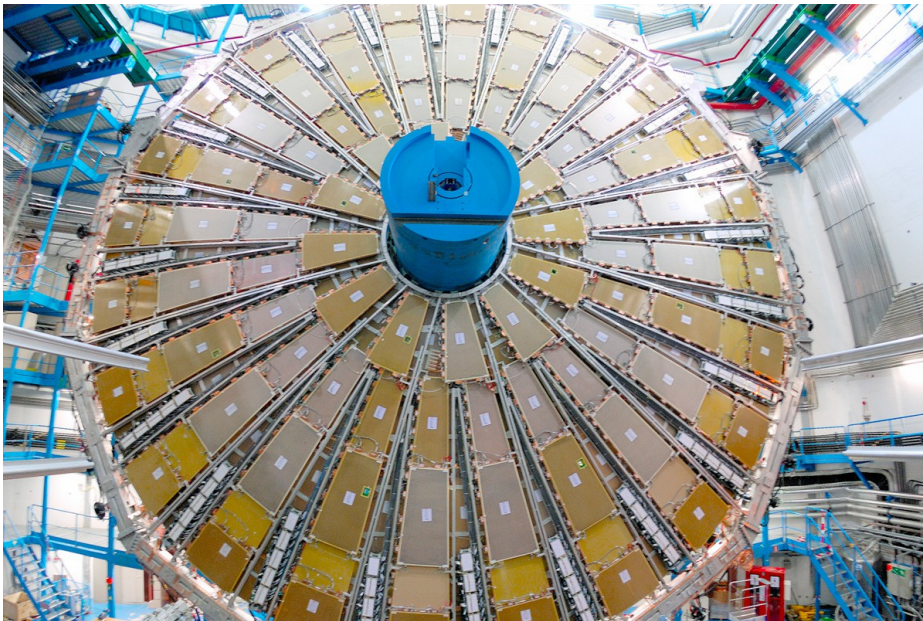
- Ge, Si, Diamond,...
- pixels and strips



With what?

Gaseous detectors

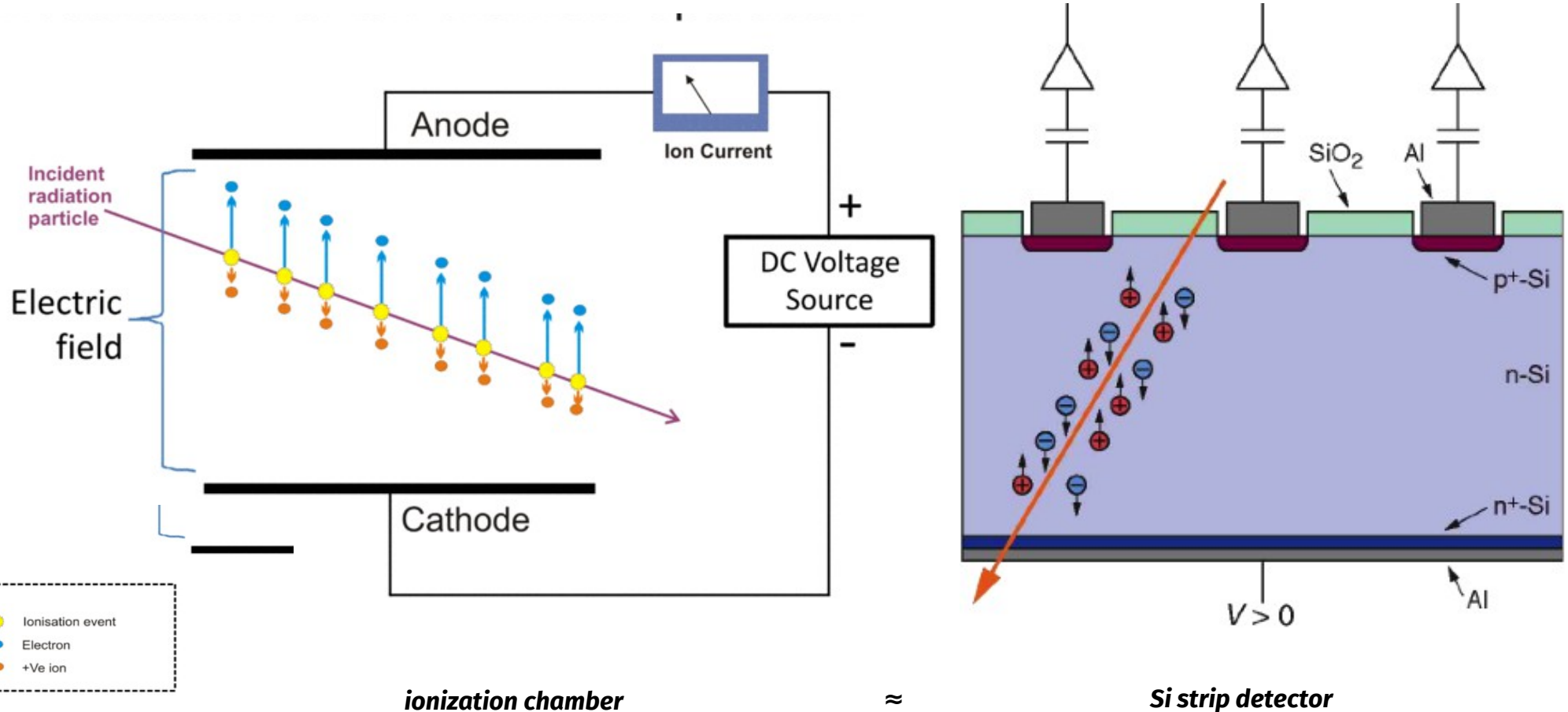
- drift tubes, resistive plate chambers, cathode strip chambers, gas electron multipliers, ...
- usually for outer tracking



How?

While transversing a medium a charged particle leaves an ionization trace

- create depletion zone in between electrodes: gaseous, liquid or solid-state (semi-conductor)
- ionization charges drift towards electrodes
- amplify electric charge signal and deduce position from signals collected in individual strips



Gaseous versus solid state

In solid state detectors ionization energy converts in e-h pairs

- 10 times smaller with respect to gaseous-based ionization
- charge is increased → improved E resolution

		Gas		Solid state
Density (g/cm ³)	Low	C ₂ H ₂ F ₄	High	Si
Atomic number (Z)	Low	(~95% for CMS RPC)	Moderate	
Ionization energy (ε _i)	Moderate	30eV	Low	3.6eV
Signal speed	Moderate	10ns-10μs	Fast	<20ns

$$n = \frac{E_{loss}}{E_{eh}} \rightarrow \frac{\sigma_E}{E} \propto \frac{1}{\sqrt{n}} \propto \sqrt{\frac{E_{eh}}{E_{loss}}}$$

Gaseous versus solid state

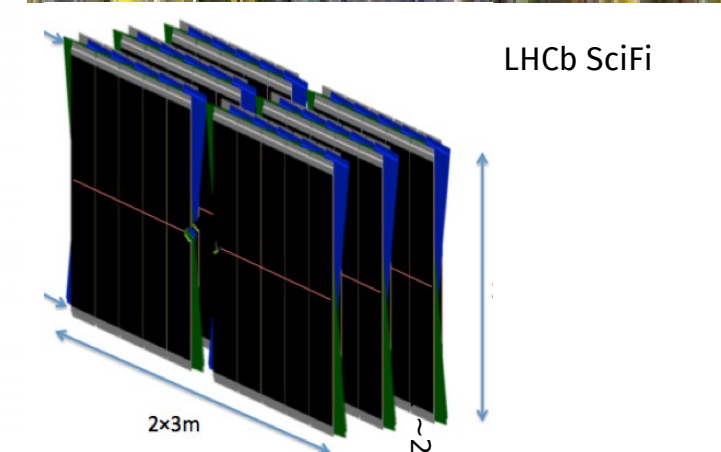
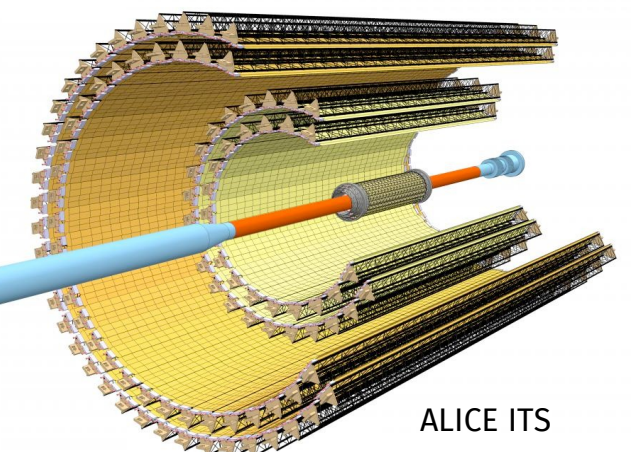
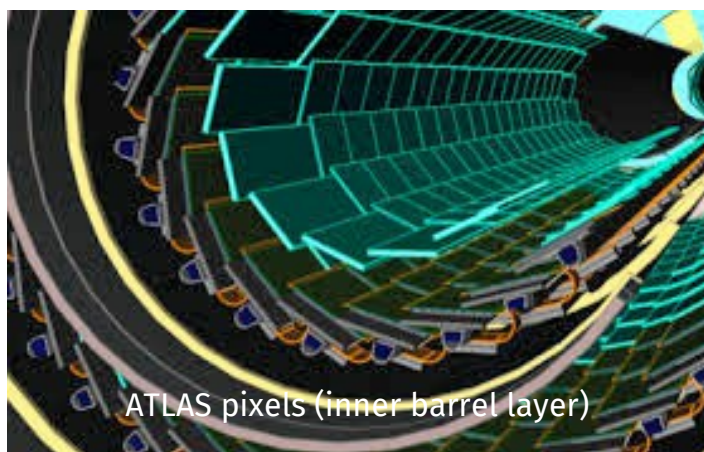
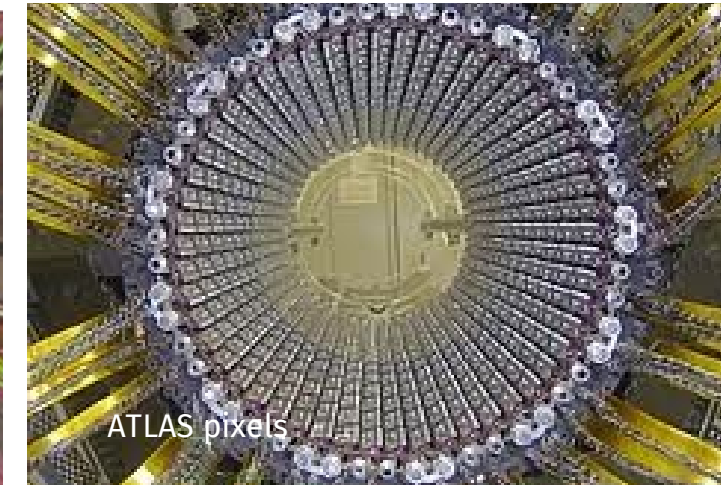
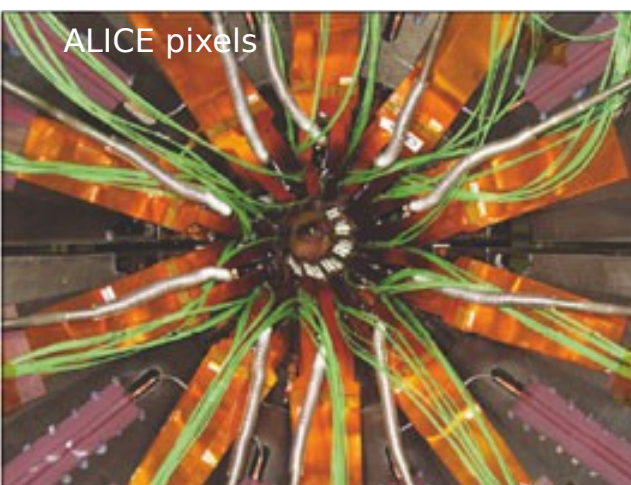
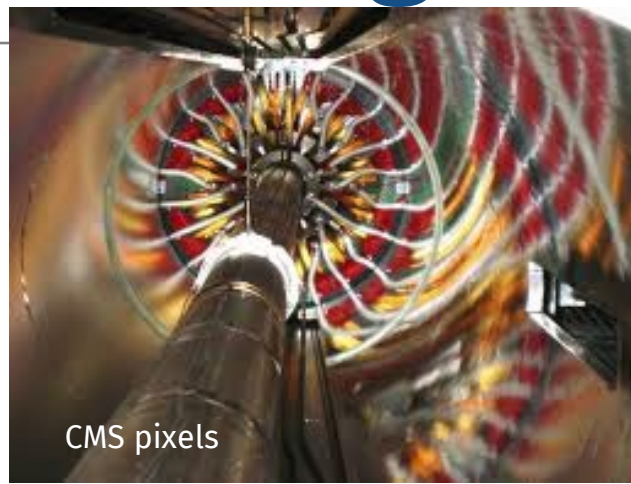
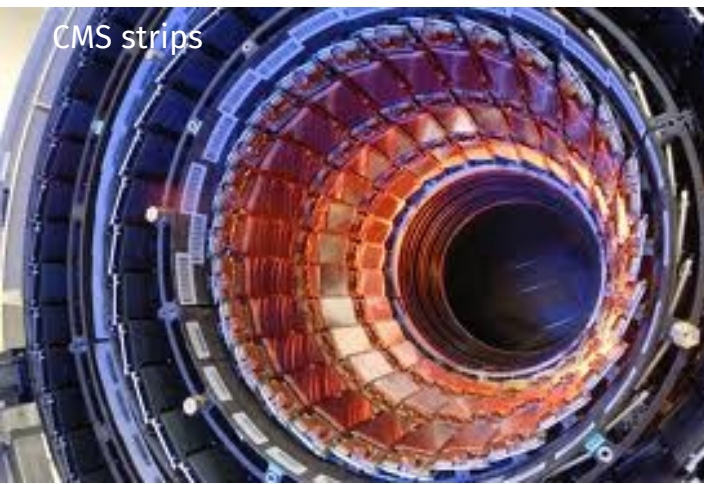
Higher density materials are used in solid state detectors

- charge collected is proportional to the thickness
- most probable value for Silicon

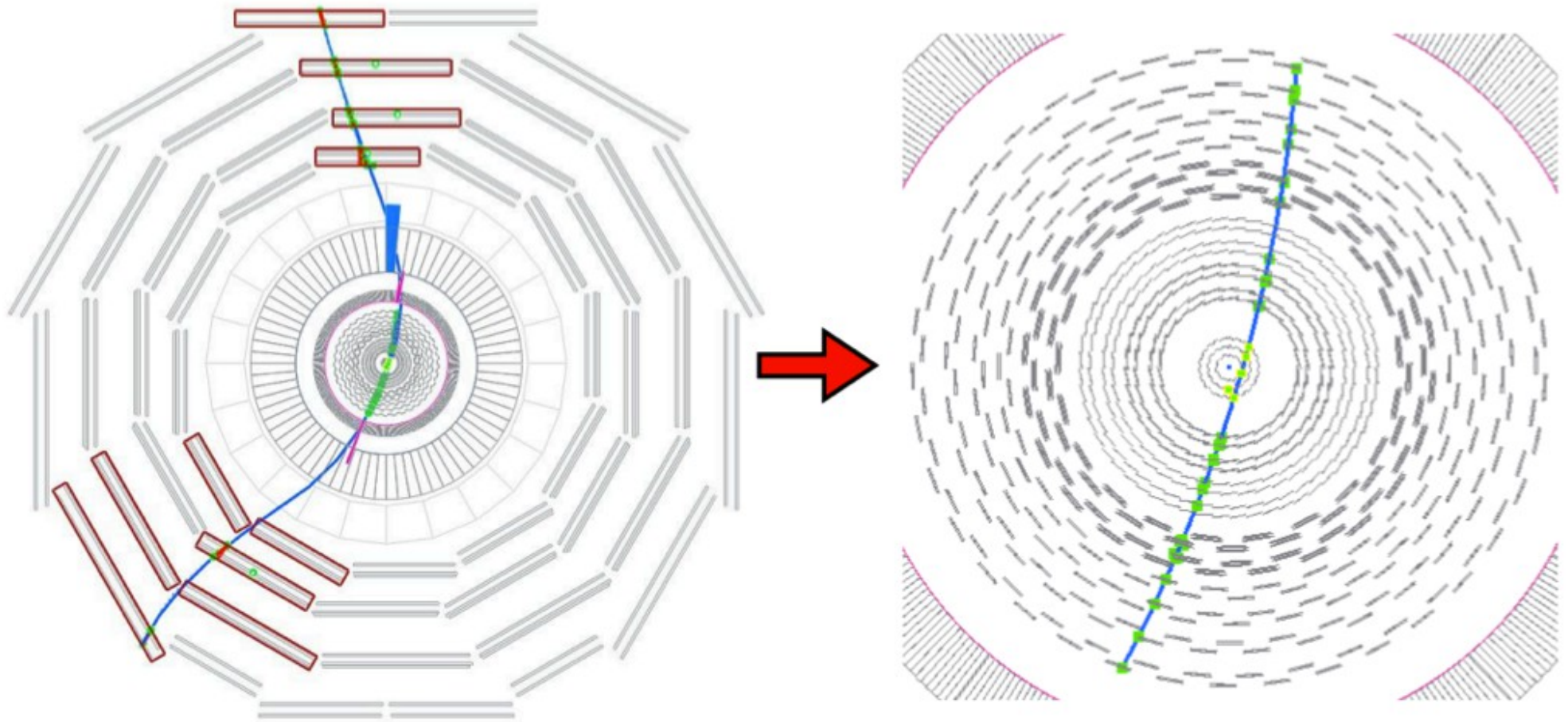
$$\frac{\Delta_p}{x} \sim 0.74 \cdot 3.876 \text{ MeV/cm} \rightarrow N_{eh} \sim \frac{23 \cdot 10^3}{300 \mu\text{m}}$$

- excellent spatial resolution: short range for secondary electrons

Inner tracking at the LHC



Outer \leftrightarrow inner tracking

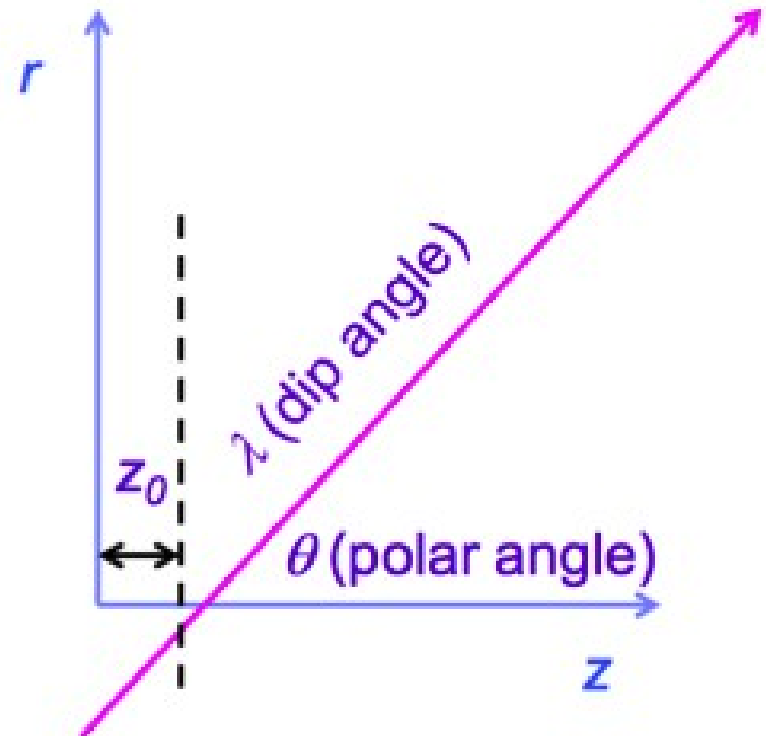
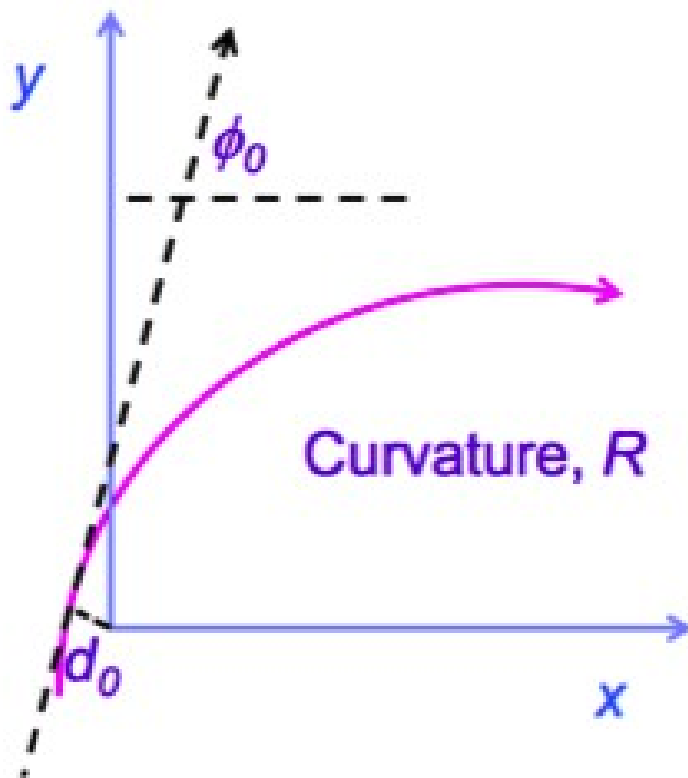


Coordinates for tracking

The LHC experiments use a uniform B field along the beam line (z-axis)

- trajectory of charged particles is an helix – radius R
- use transverse (xy) and longitudinal (rz) projections
- pseudo-rapidity: $\eta = -\ln \tan \frac{\theta}{2}$ transverse momentum: $p_T = p \sin \theta = p / \cosh \eta$

Impact parameter is defined from distance of closest approach to primary vertex



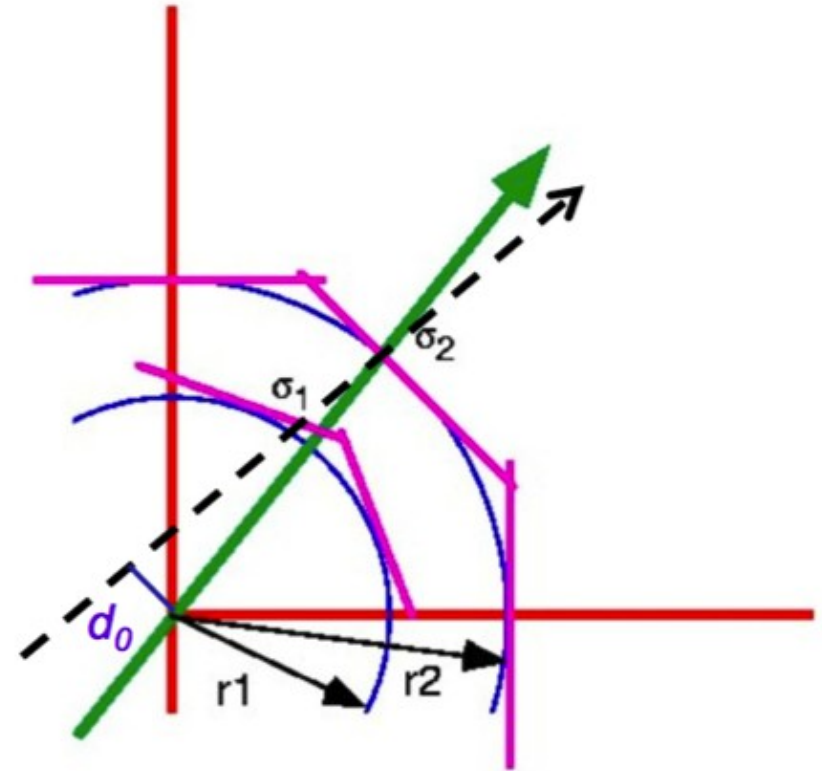
Impact parameter reconstruction

Depends on radii+space point precisions

For two layers we expect

$$\sigma_{d_0}^2 = \frac{r_2^2 \sigma_1^2 + r_1^2 \sigma_2^2}{(r_2 - r_1)^2}$$

- Improve with small r_1 , large r_2
- Improves with better σ_i



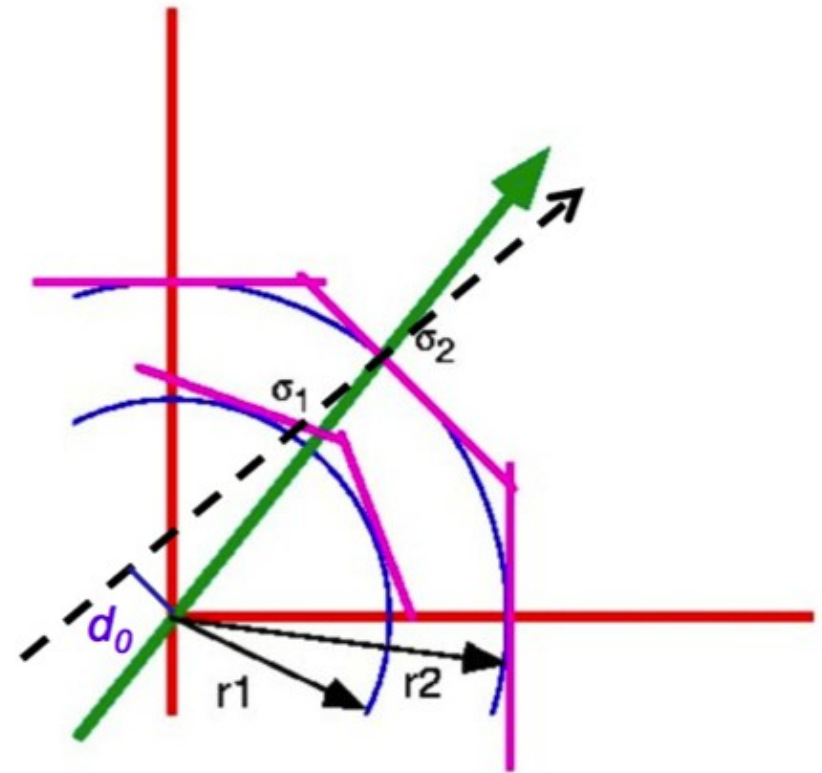
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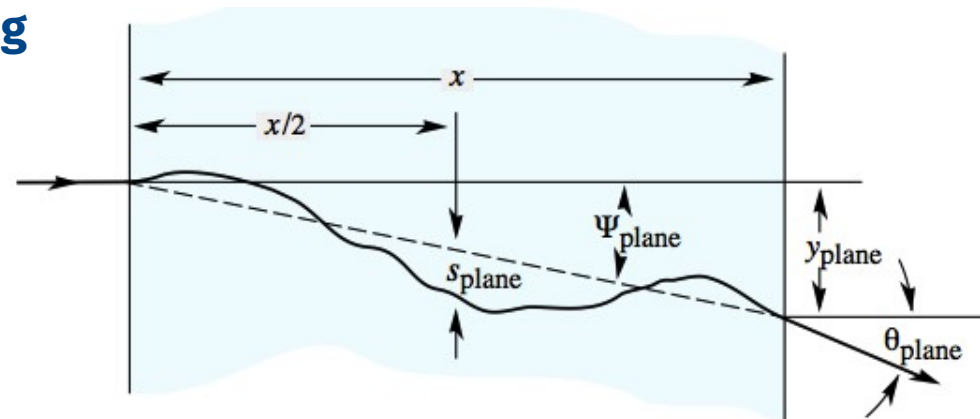
Precision is degraded by multiple scattering

- Gaussian approximation is valid
- Width given by

$$\theta_0 = \frac{13.6 \text{ MeV}}{\beta c p} z \sqrt{x / X_0} [1 + 0.038 \ln(x / X_0)]$$

$$\sigma_{d_0} \sim \theta_0$$

- extra degradation term for d_0



Resolution for the impact parameter

For a track with $\theta \neq 90^\circ$ we can write $r \rightarrow r/\sin\theta$

By substitution in the formulas of the previous slide we have:

$$\sigma_{d_0} \sim \sqrt{\frac{r_2^2 \sigma_1^2 + r_1^2 \sigma_2^2}{(r_2 - r_1)^2}} \oplus \frac{r}{p \sin^{3/2} \theta} \rightarrow a \oplus \frac{b}{p_T \sin^{1/2} \theta}$$

geometry-dependent

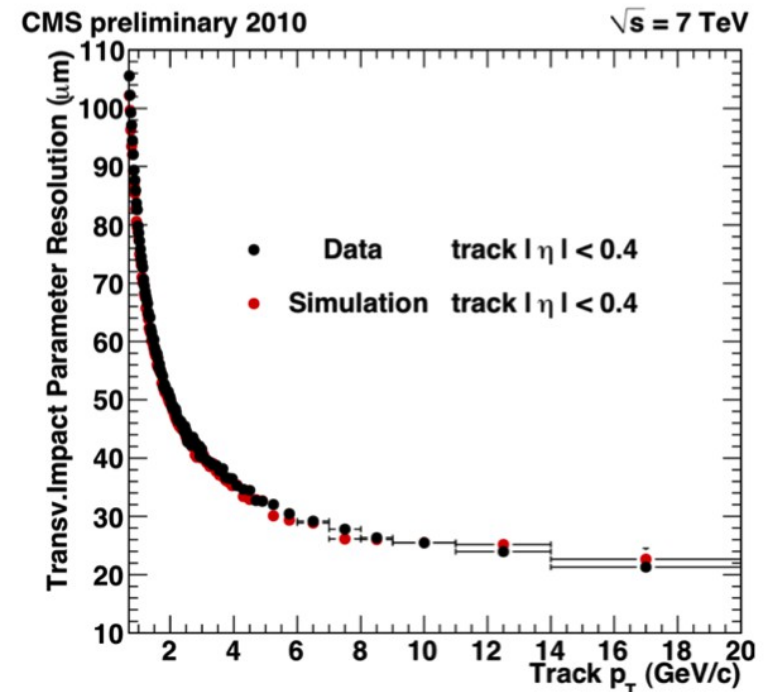
Material- and p_T -dependent

Typical resolution:

- 100 μm @ 1 GeV 20 μm @ 20 GeV

Typical lifetimes (rest frame)

- B \sim 500 μm $D_0 \sim$ 120 μm $\tau \sim$ 87 μm



Momentum measurement

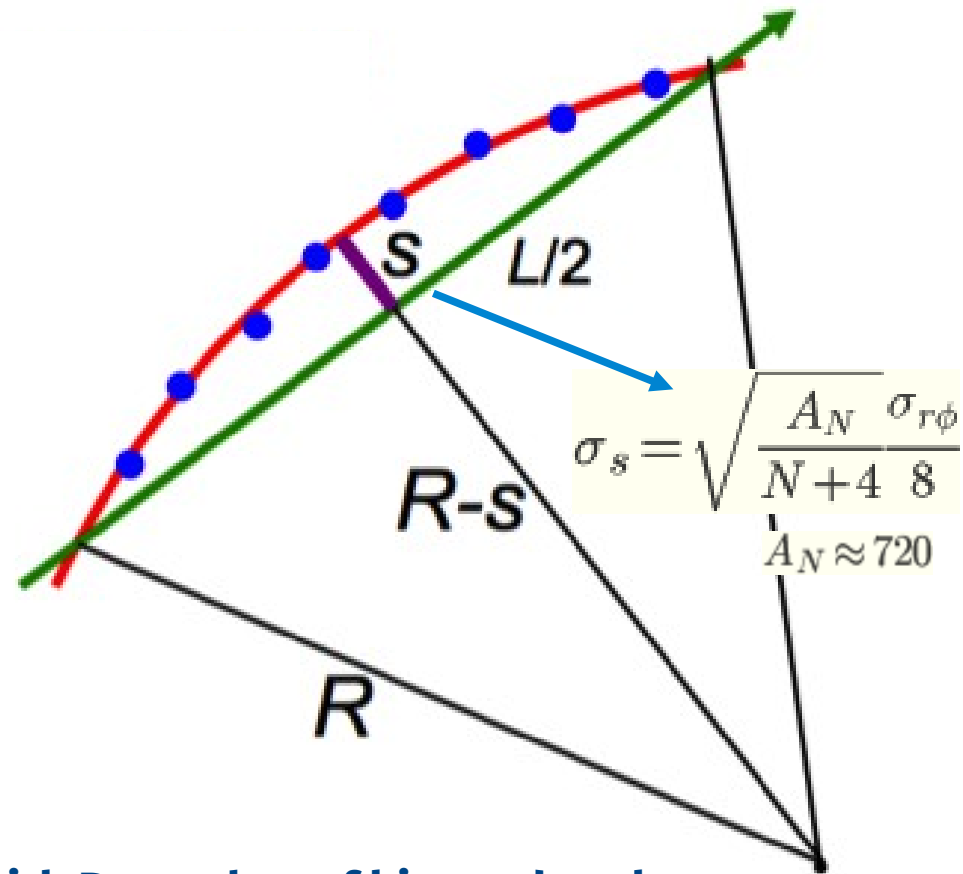
Circular motion under uniform B-field

$$p_T [\text{GeV}] = 0.3 \times q \times B [\text{T}] \times R [\text{m}]$$

Typically measure the sagitta

- deviation to straight line relates to R by

$$R = \frac{L^2}{2s} + \frac{s}{2} \approx \frac{L^2}{2s}$$



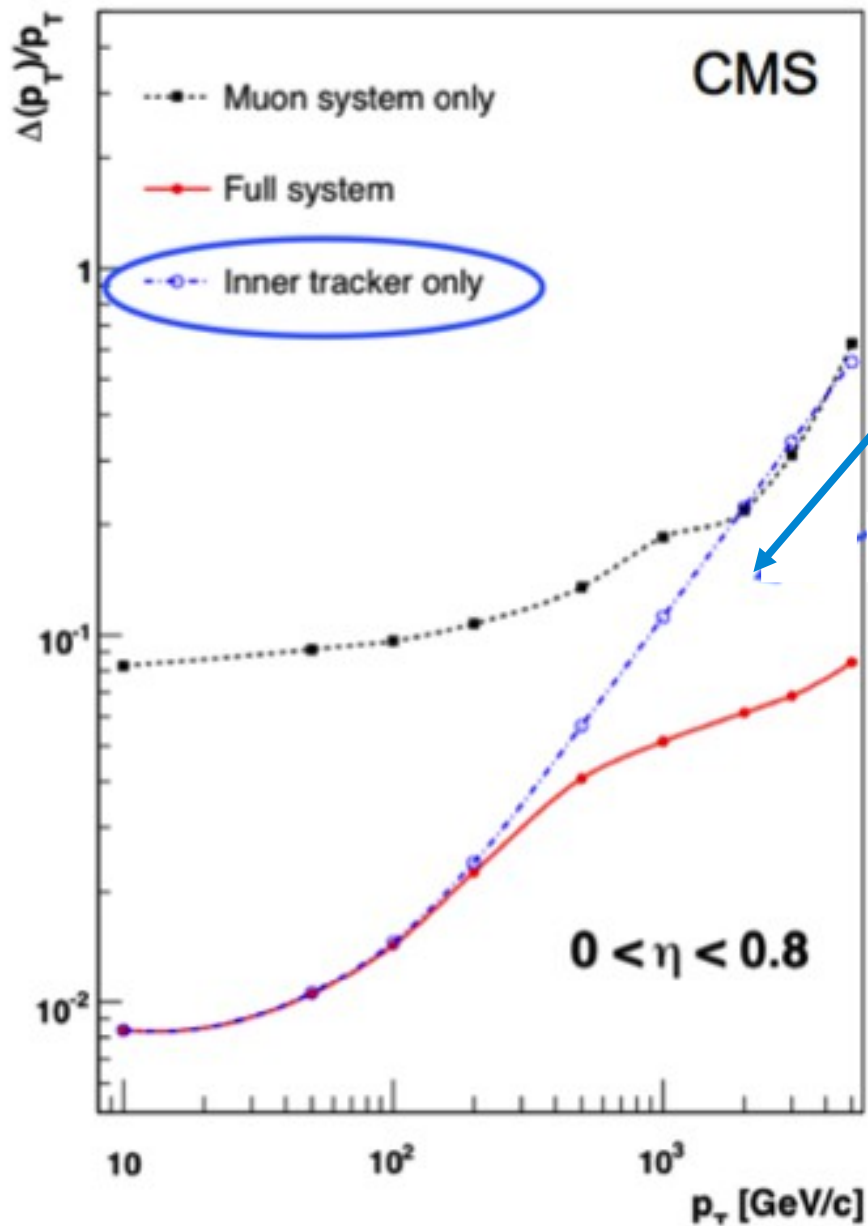
Uncertainty in p_T measurement improves with B, number of hits and path

$$\frac{\sigma_{p_T}}{p_T} = \frac{8p_T}{0.3BL^2} \sigma_s$$

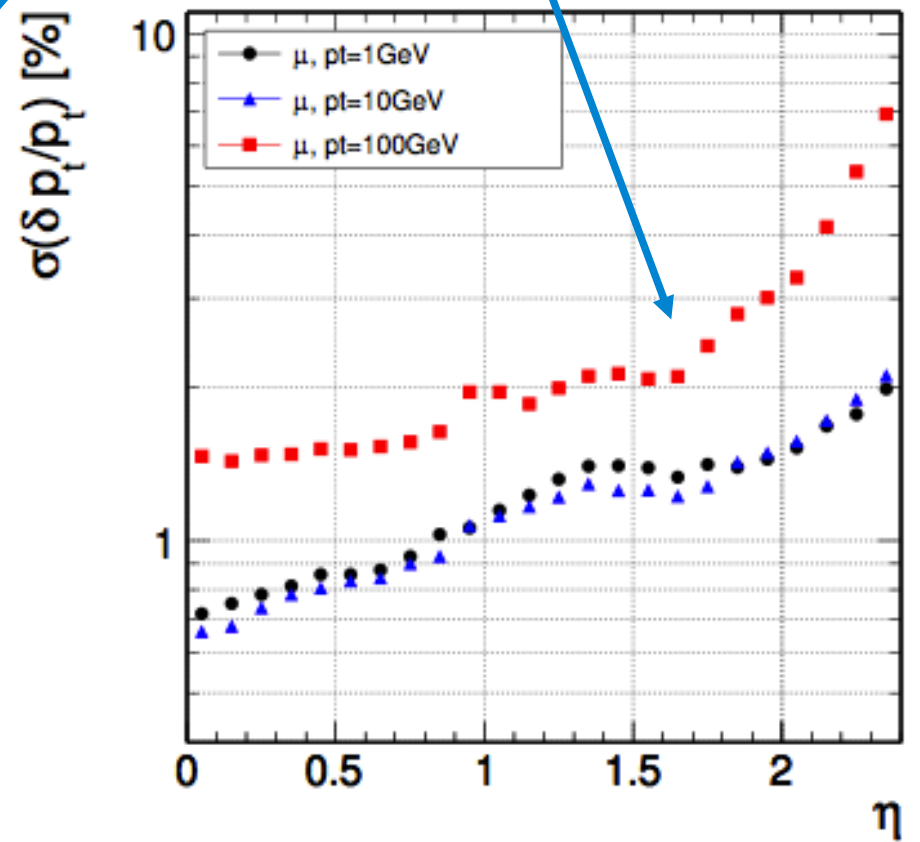
Multiple scattering introduces, again extra degradation

$$\frac{\sigma_{p_T}}{p_T} \sim a p_T \oplus \frac{b}{\sin^{1/2}\theta}$$

Momentum resolution



$$\frac{\sigma_{p_T}}{p_T} \sim a p_T \oplus \frac{b}{\sin^{1/2}\theta}$$



Si-based detectors

Usage of Si-based trackers for HEP

Kemmer, 1979 transferred Si-technology for electrons to detector - NIM 169(1980)499

NA11/32 spectrometer at CERN →

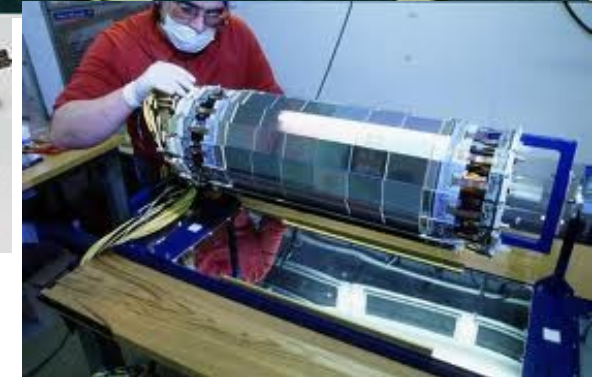
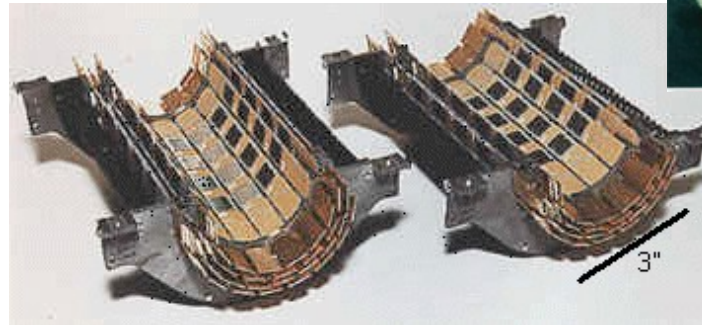
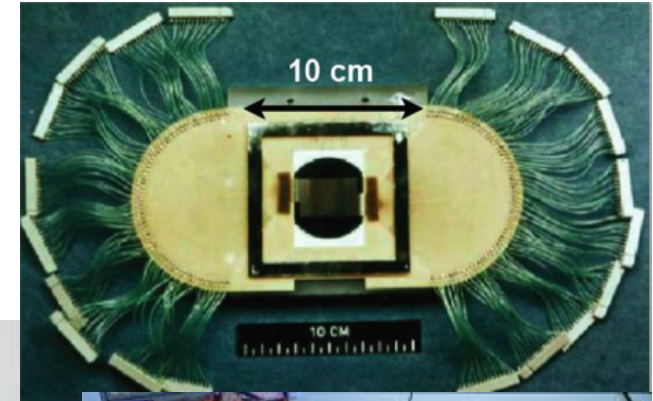
- 6 planes Si-Strip, <2k channels
- Resolution $\sim 4.5\mu\text{m}$

SLD vertex detector at SLAC →

- 120-307 M pixels: $0.4\%X_0$
- Resolution $<4\mu\text{m}$, $d_0 \sim 11-9\mu\text{m}$

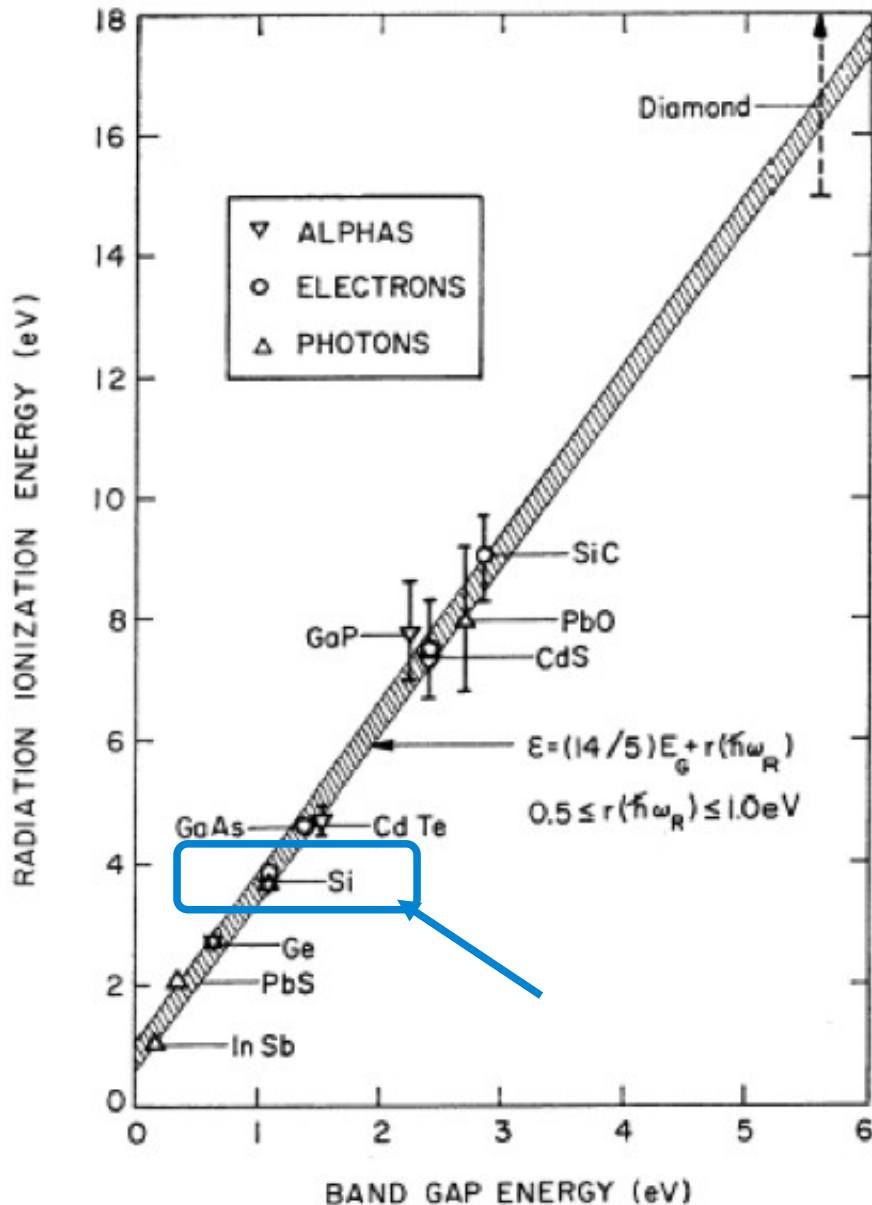
ALEPH detector at LEP →

- Enable precise measurements for B-physics (lifetime, b-tagging)



Experiment	Detectors	Channels (10^3)	Si area [m^2]
Aleph (LEP)	144	95	0.49
CDF II (TEV)	720	405	1.9
D0 II (TEV)	768	793	4.7
AMS II	2300	196	6.5
ATLAS (LHC)	4088	6300	61
CMS (LHC)	15148	10000	200

Si properties



Widely used in high energy physics and industry

Low ionization energy

- Band gap is 1.12 eV
- Takes 3.6 eV to ionize atom
→ remaining yields phonon excitations
- Long free mean path
→ good charge collection efficiency
- High mobility
→ fast charge collection
- Low Z
→ reduced multiple scattering

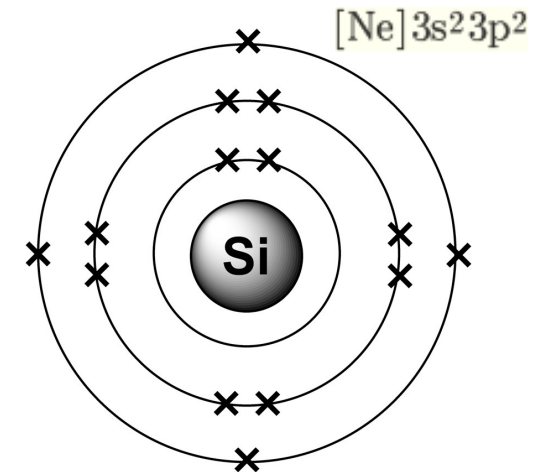
Good electrical properties (SiO₂)

Good mechanical properties

- Easily patterned to small dimensions
- Can be operated at room temperature
- Crystalline
→ resilient against radiation

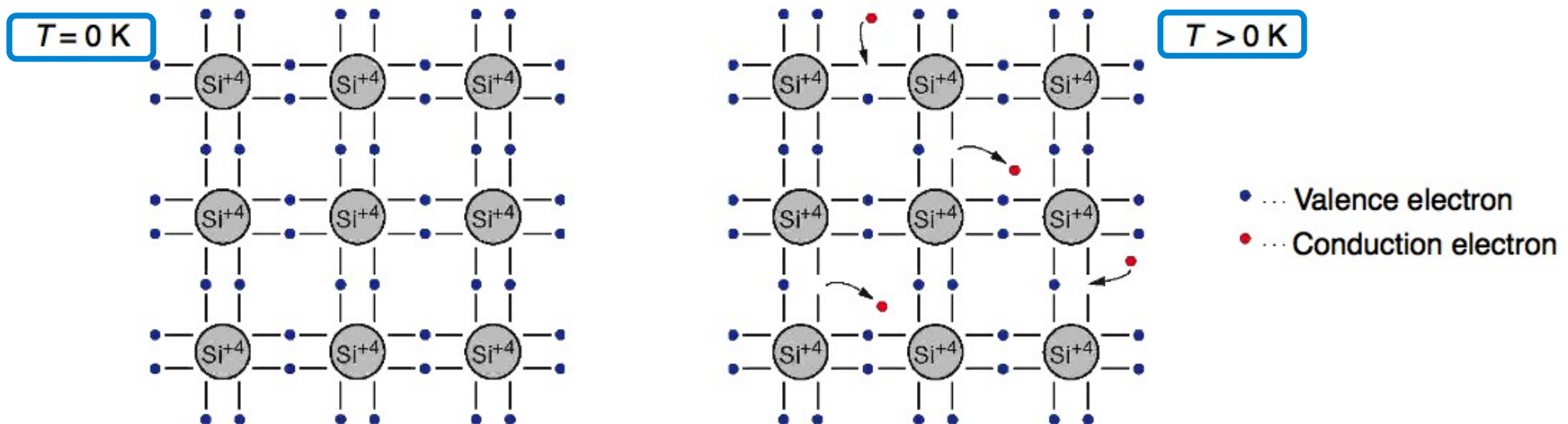
Bond model of semi-conductors

Covalent bonds formed after sharing electrons in the outermost s



Thermal vibrations

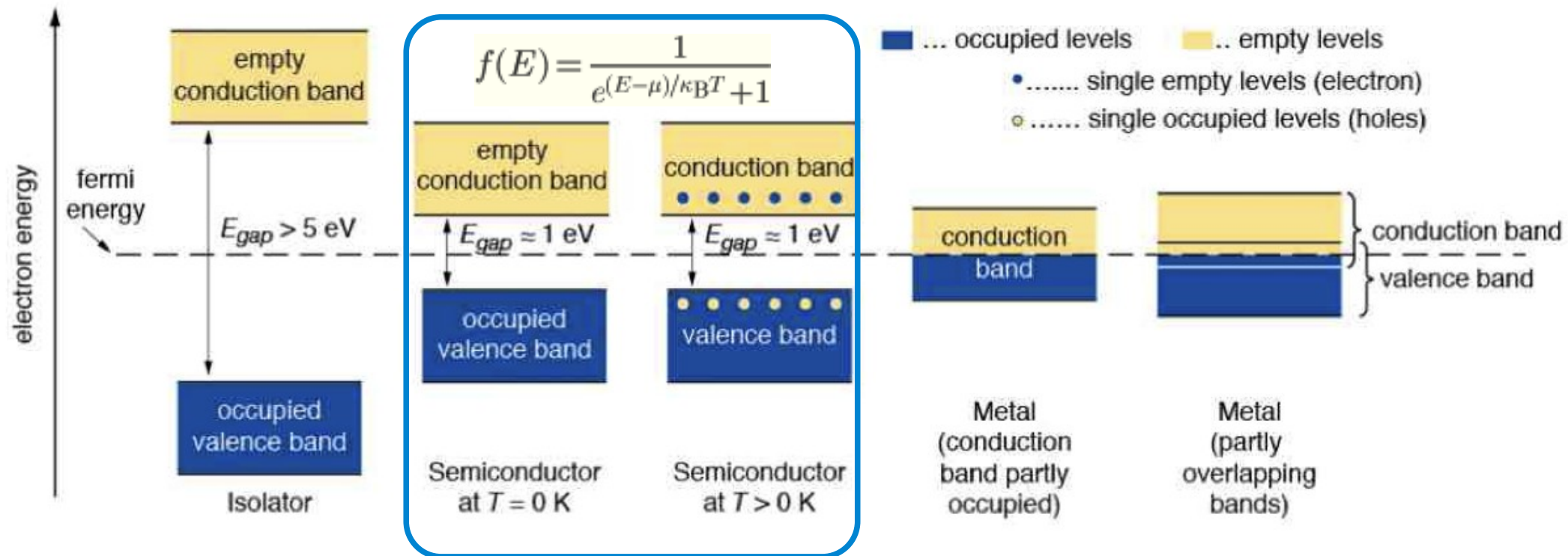
- break bonds and yield electron conduction (free e⁻)
- remaining open bonds attract free e⁻ → holes change position → hole conduction



Energy bands in semi-conductors

In solids, the quantized energy levels merge

- Metals: conduction and valence band overlap
- Insulators and semi-conductors: conduction and valence band separated by energy (band) gap
- If μ (band gap) sufficiently low : electrons fill conduction band according to Fermi-Dirac statistics



Intrinsic noise: intrinsic carrier concentration

Energy state occupation probability follows Fermi statistics distribution

Typical behaviour @ room temperature

- excited electrons move to conduction band
- electrons recombine with holes

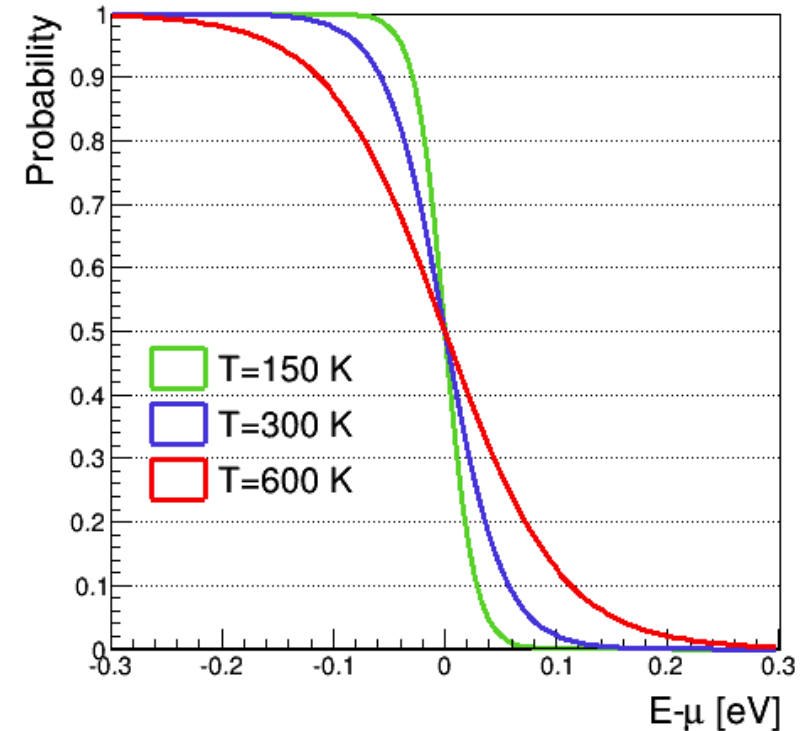
Excitation and recombination in thermal equilibrium

Intrinsic carrier concentration given by

$$n_e = n_h = n_i = A \cdot T^{3/2} \cdot e^{-E_g/k_B T}$$

with $A=3.1 \times 10^{16} \text{ K}^{-3/2} \text{ cm}^{-3}$ and $E_g/2k_B=7 \times 10^3 \text{ K}$

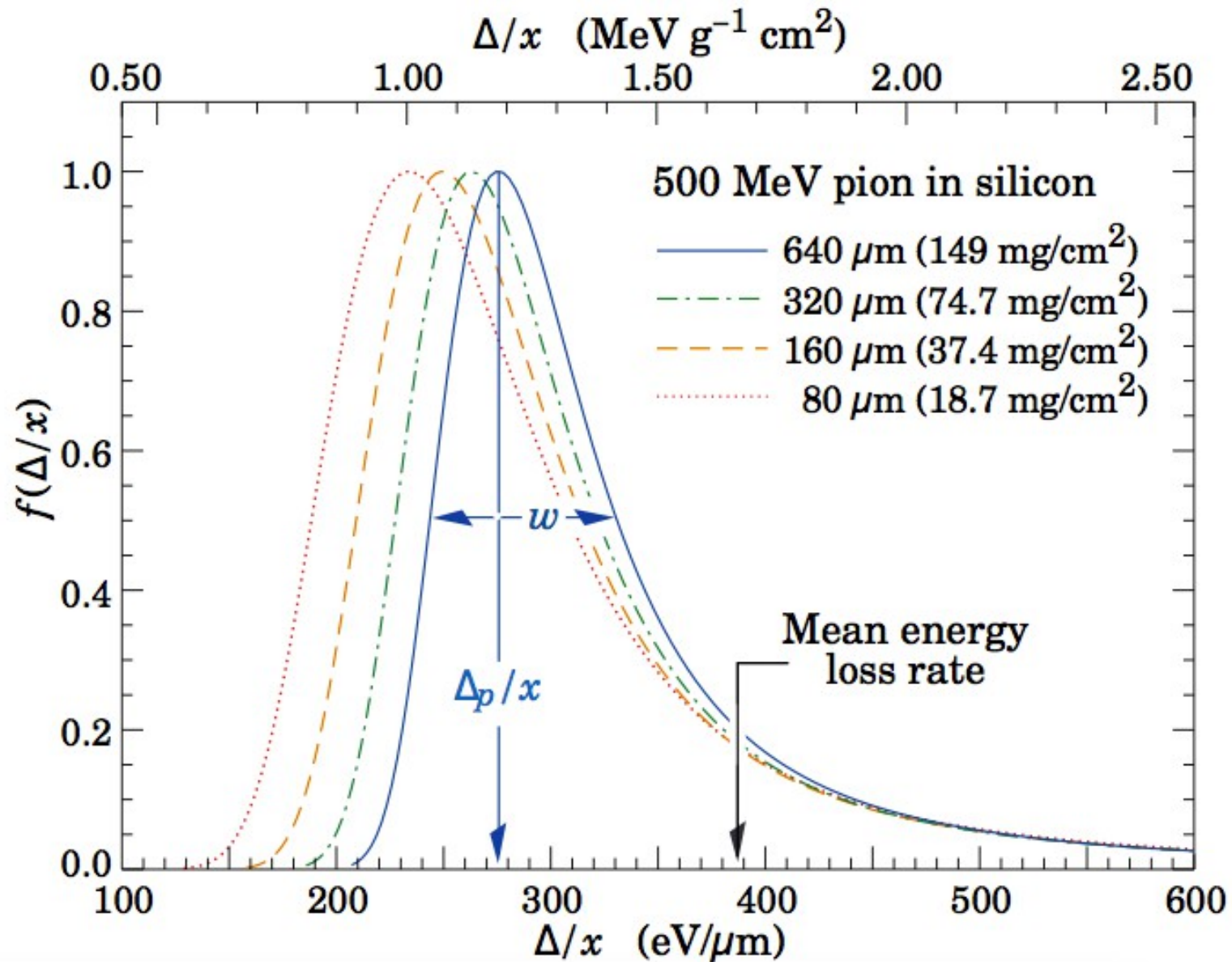
$$f(E) = \frac{1}{e^{(E-\mu)/k_B T} + 1}$$



$$n_i \sim 1.45 \times 10^{10} \text{ cm}^{-3}$$

$\Rightarrow 1/10^{12}$ Si atoms is ionized

What about signal? energy loss in the Si

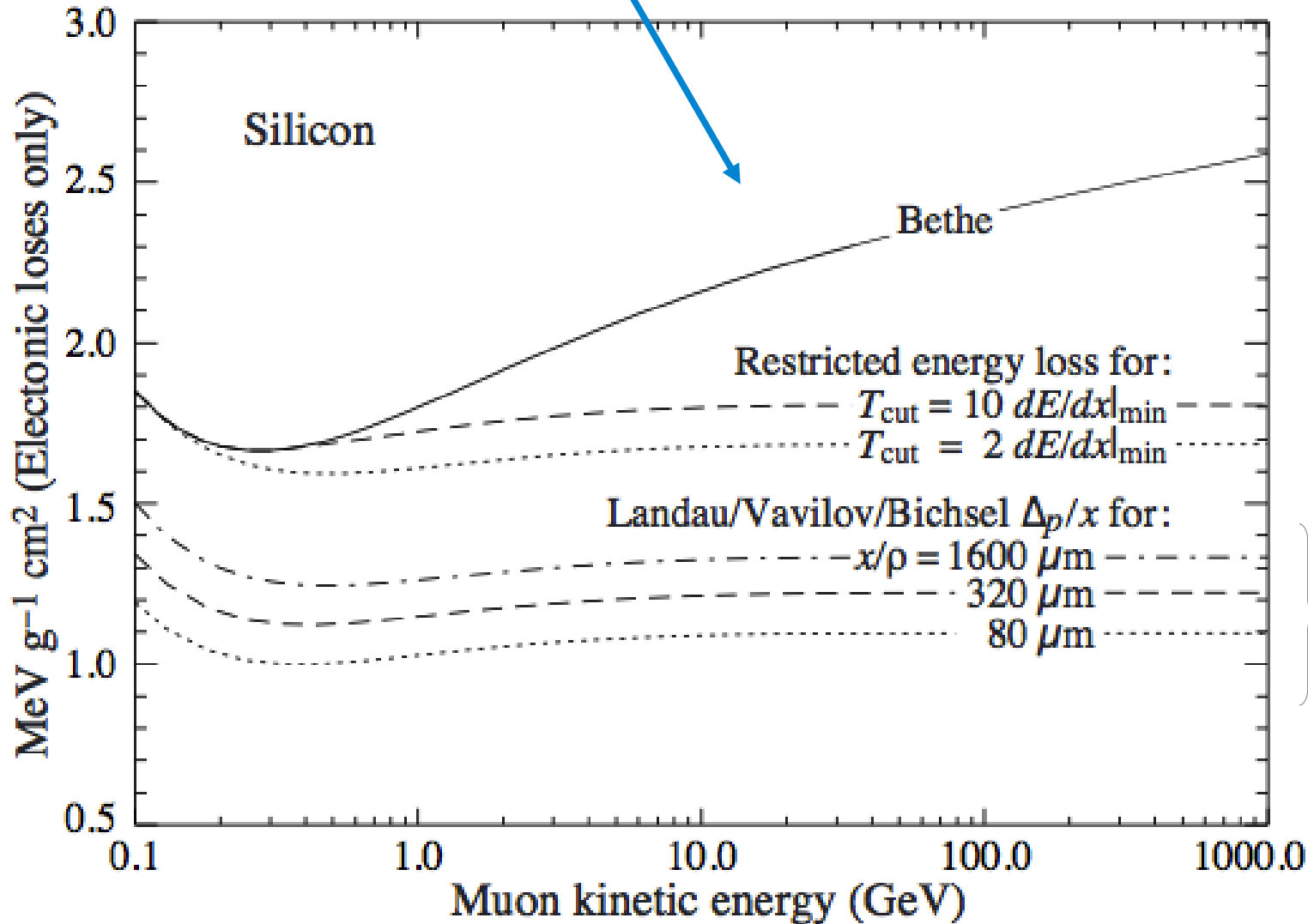


Most probable value of the Landau distribution for energy loss defines the minimum ionizing particle

MIP as function of the energy: Bethe-Bloch curve

Example: Si detector with thickness $d=300\mu\text{m}$

$$\left\langle -\frac{dE}{dx} \right\rangle = K z^2 \frac{Z}{A} \frac{1}{\beta^2} \left[\frac{1}{2} \ln \frac{2m_e c^2 \beta^2 \gamma^2 W_{\text{max}}}{I^2} - \beta^2 - \frac{\delta(\beta\gamma)}{2} \right]$$



Slight dependency on Si sensor thickness, approx. constant at large $\beta\gamma$

Intrinsic S/N in a Si detector

For a 300 μm thickness sensor

- Minimum ionizing particle (MIP) creates:

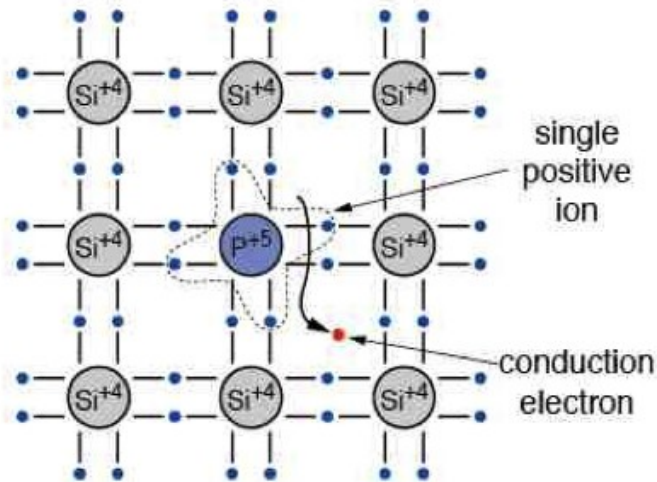
$$\frac{1}{E_{\text{eh}}} \frac{dE}{dx} \cdot d = \frac{3.87 \cdot 10^6 \text{eV/cm}}{3.63 \text{eV}} \cdot 0.03 \text{cm} = 3.2 \cdot 10^4 \text{eh pairs}$$

- Intrinsic charge carriers (recall slide 43):

$$n_i \cdot d = 1.45 \cdot 10^{10} \text{cm}^{-3} \cdot 0.03 \text{cm} = 4.35 \cdot 10^8 \text{eh pairs}$$

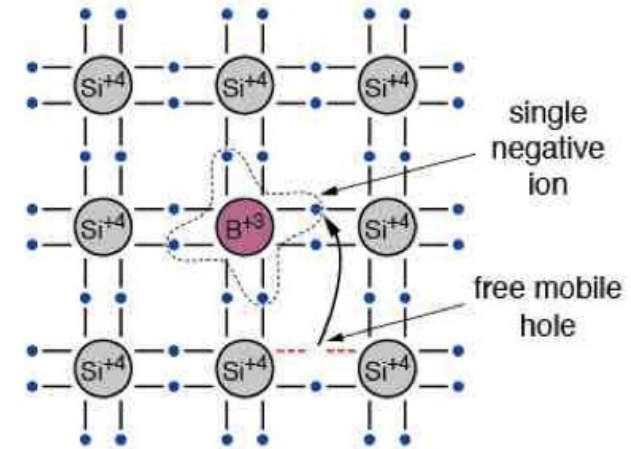
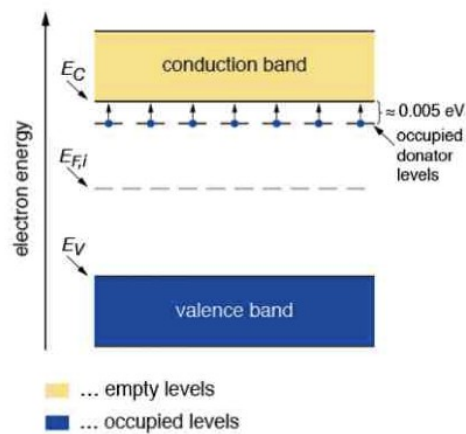
Number of thermally-created e-h pairs exceeds mip signal by factor 10^4 !

How to improve S/N: first dope Si



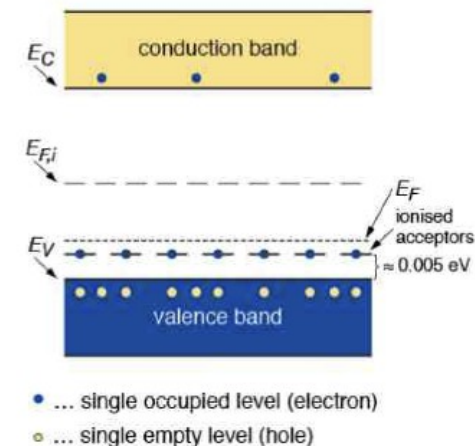
n-type

- Group 5 atom: P, As, Sb
- Loosely bound valence electron
- Tends to leave a positive ion in grid



p-type

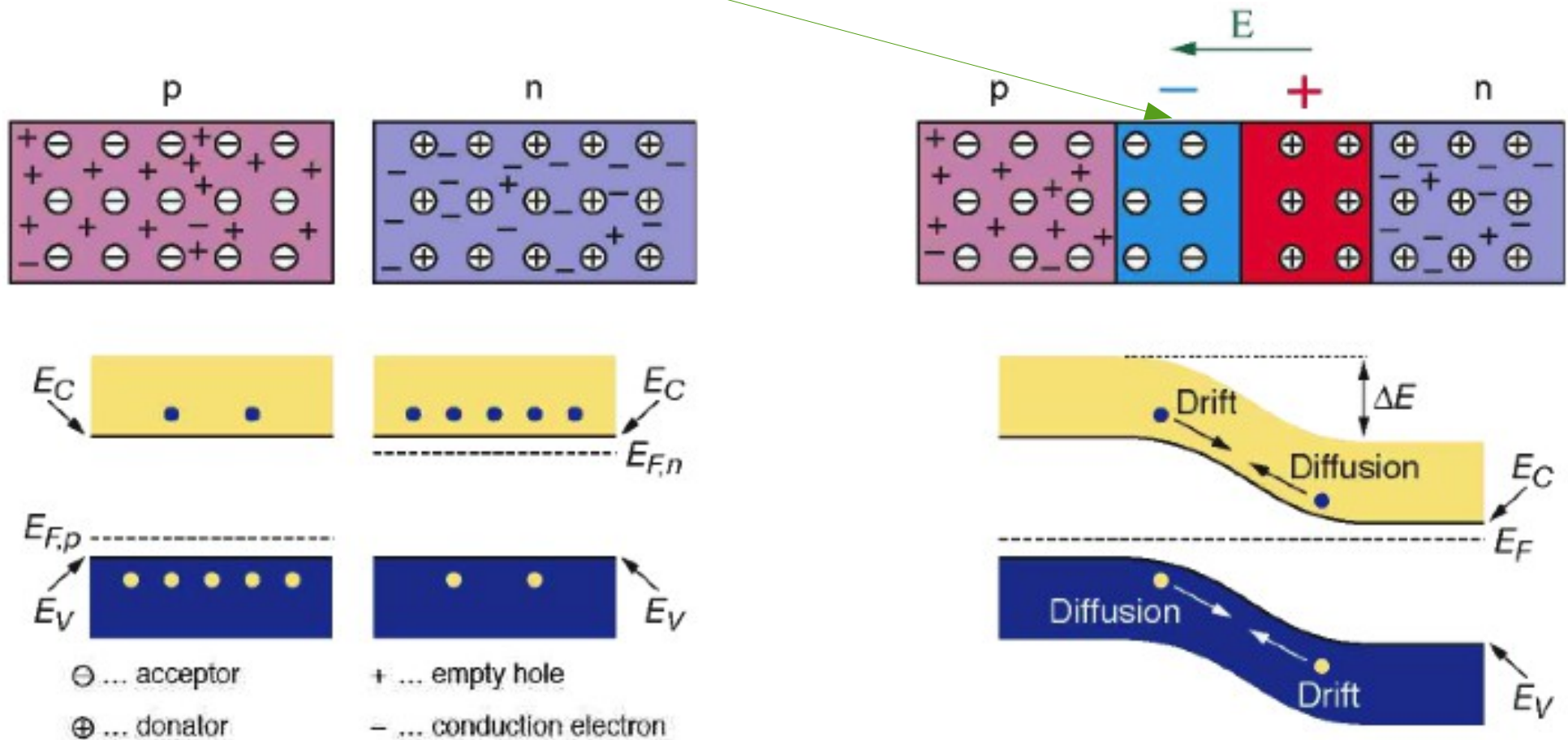
- Group 3 atom: B, Al, Ga, In
- open valence bonds attracts electrons
- Tends to leave negative ion in the grid



How to improve S/N: second make a junction of doped Si

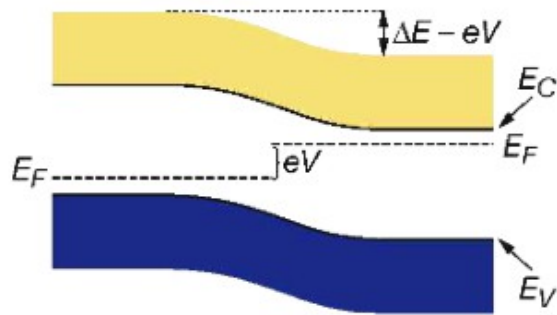
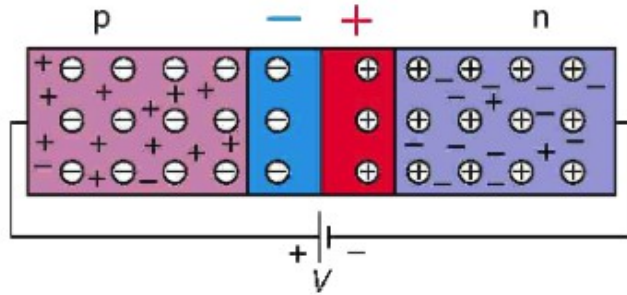
Difference in Fermi levels at the interface of n-type or p-type

- diffusion of excess of charge carriers until thermal equilibrium (or equal Fermi level)
- **remaining ions create a depletion zone:** electric field prevents further the diffusion



How to improve S/N: finally bias the junction

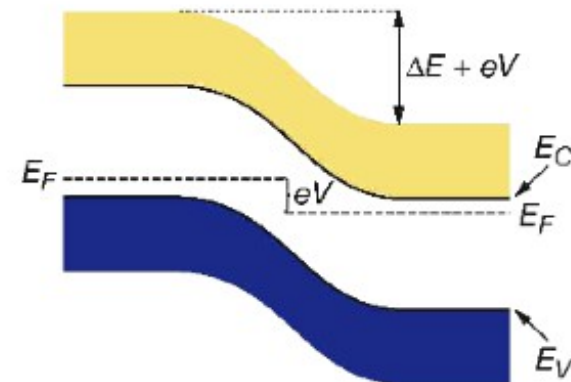
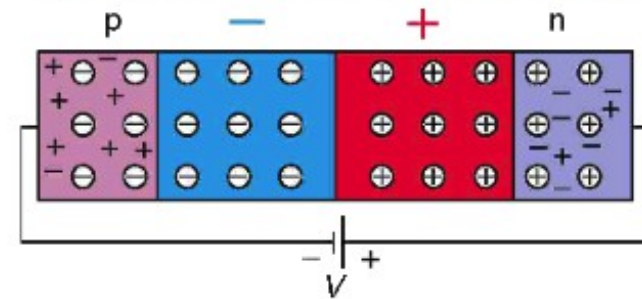
p-n junction with forward bias



Forward-biased junction

- Anode to p, cathode to n
- Depletion zone becomes narrower
- Smaller potential barrier facilitates diffusion
- Current across the junction tends to increase

p-n junction with reverse bias



Reverse-biased junction

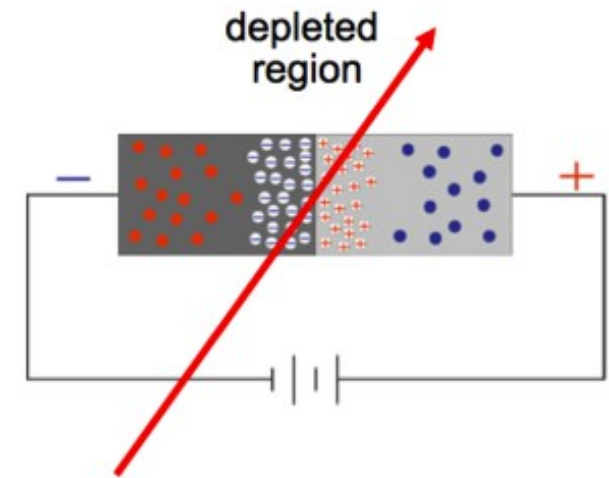
- Anode to n, cathode to p
- e,h pulled out of the depletion zone
- Potential barrier is suppressed
- Only leakage current across junction

Depletion zone: width and capacitance

Characterize depletion zone from Poisson equation with charge conservation: $\nabla^2 \phi = -\frac{\rho_f}{\epsilon}$

Typically: $N_a = 10^{15} \text{ cm}^{-3}$ (p region) $\gg N_d = 10^{12} \text{ cm}^{-3}$ (n bulk)

Width of depletion zone (n bulk): $W \approx \sqrt{\frac{2\epsilon V_{\text{bias}}}{q} \cdot \frac{1}{N_d}}$

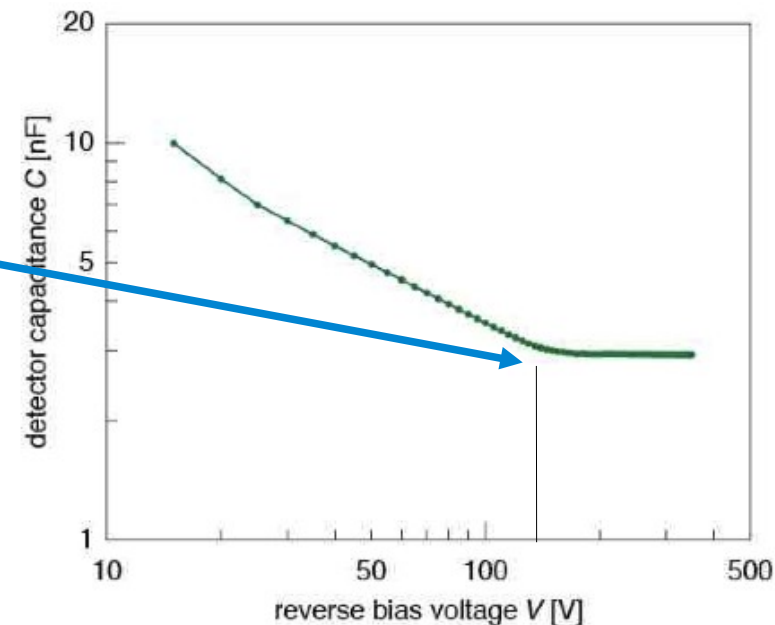


Reverse bias voltage (V)	W_p (μm)	W_n (μm)
0	0.02	23
100	0.4	363

Device behaves as parallel-plate capacitor

$$C = \frac{q}{V} = \frac{\epsilon A}{d} = A \sqrt{\frac{\epsilon q N_d}{2V_{\text{bias}}}}$$

- Depletion voltage saturates the capacitance
- Typical curve obtained for CMS strip detector

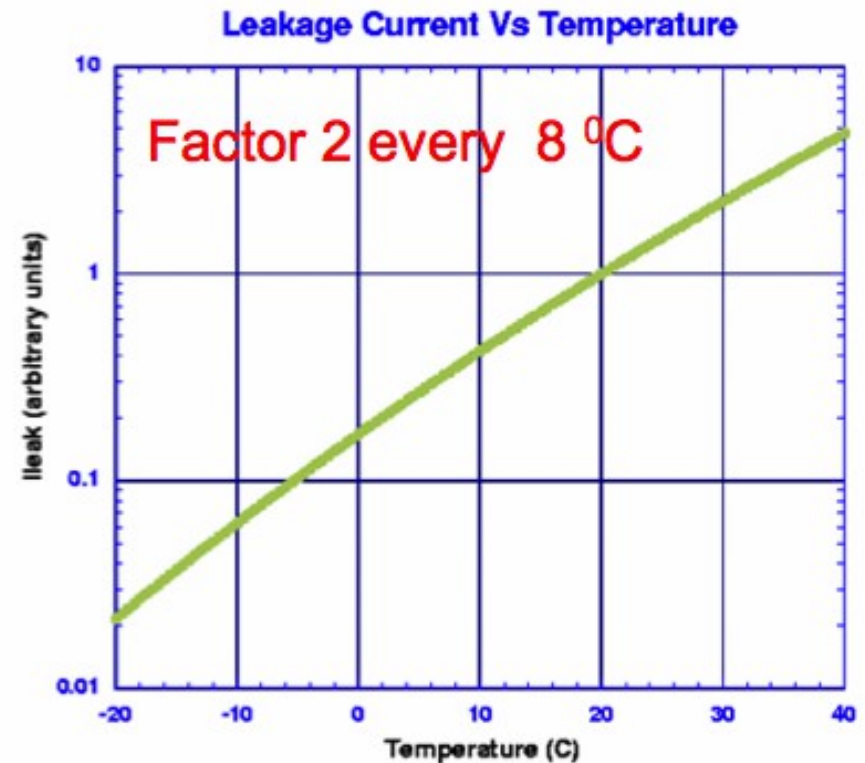
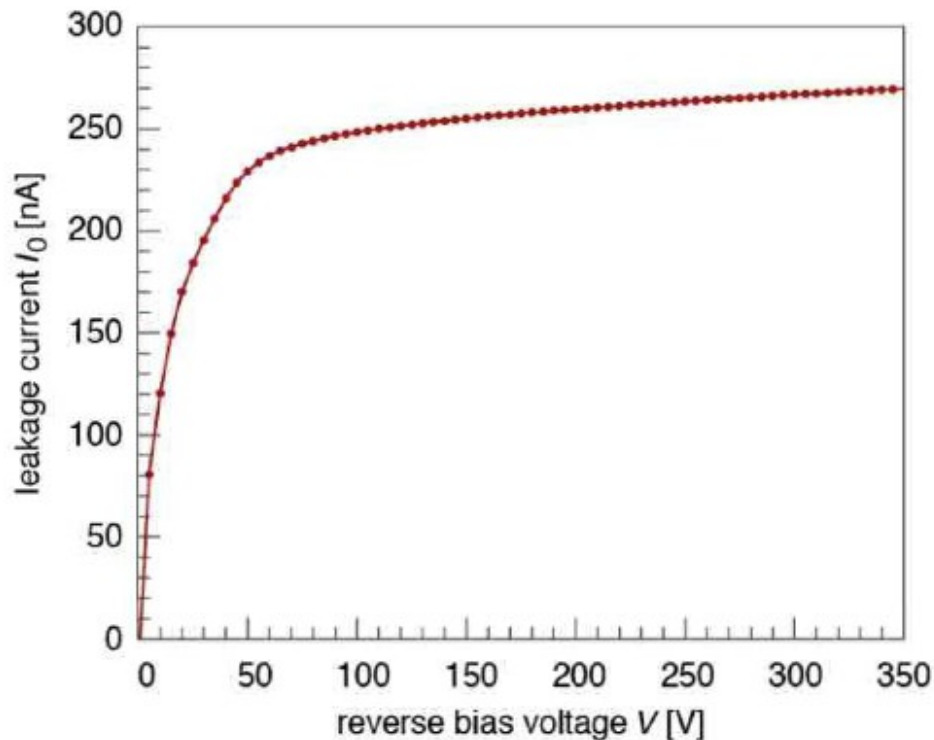


Depletion zone: leakage current

- Thermal excitation generates eh pairs
 - Reverse bias applied separates pairs
 - eh pairs do not recombine and drift
⇒ leakage current
- Depends on purity, defects and temperature

$$j_{\text{gen}} \propto T^{3/2} e^{\frac{1}{k_B T}}$$

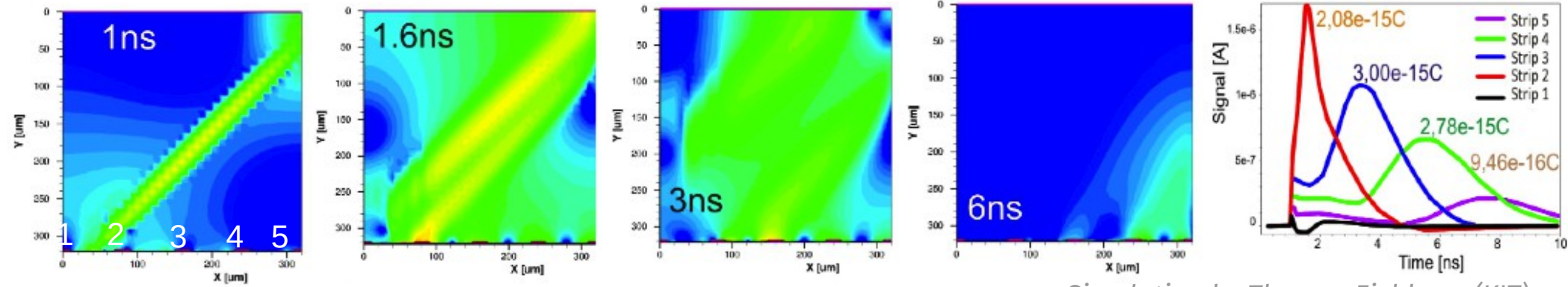
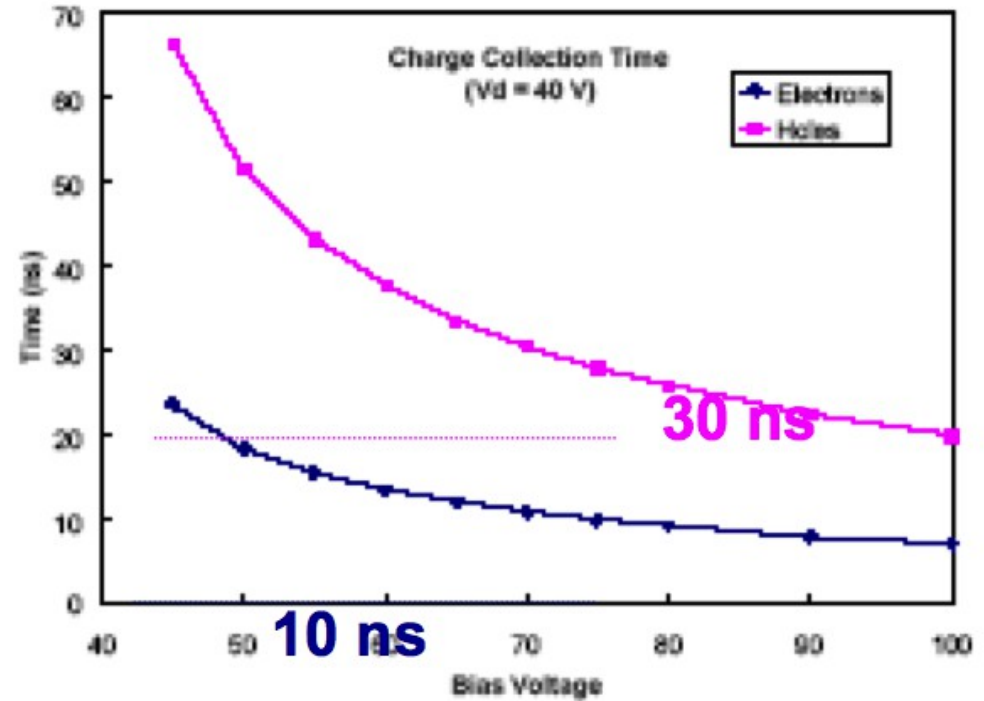
⇒ usually require detector cooling for stable operation (-30°-10°C)



Charge collection from signal deposits

eh pairs move under the electric field

- larger biases smaller collection times
- typically smaller than LHC bunch crossing



Simulation by Thomas Eichhorn (KIT)

charge collection simulation for a 45° incident particle

Factors impacting performance: S/N

Signal depends on the thickness of the depletion zone and on dE/dx of the particle

Noise suffers contributions from:

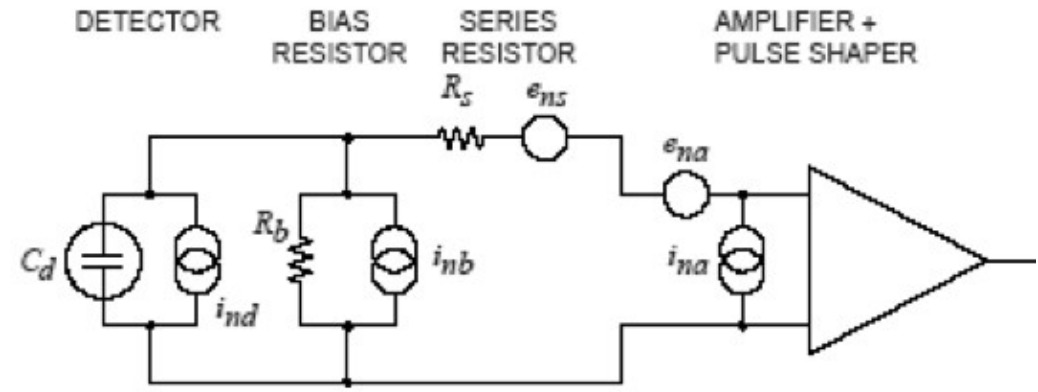
$$ENC = \sqrt{ENC_C^2 + ENC_I^2 + ENC_{R_{\parallel}}^2 + ENC_{R_{series}}^2}$$

capacitance

leakage
current

parallel
resistor

series
resistor



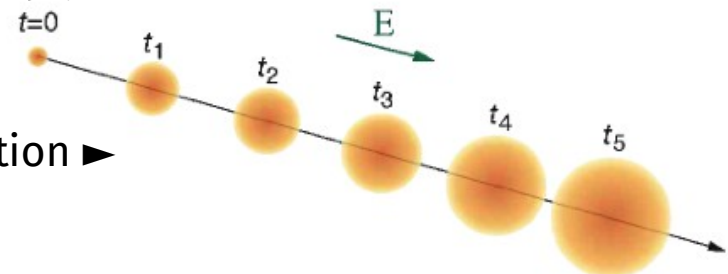
$$ENC_{peak} = (36.6 \pm 1.9) e^- / \text{cm} \cdot L + (405 \pm 27) e^-$$

$$ENC_{dec} = (49.9 \pm 3.2) e^- / \text{cm} \cdot L + (590 \pm 47) e^-$$

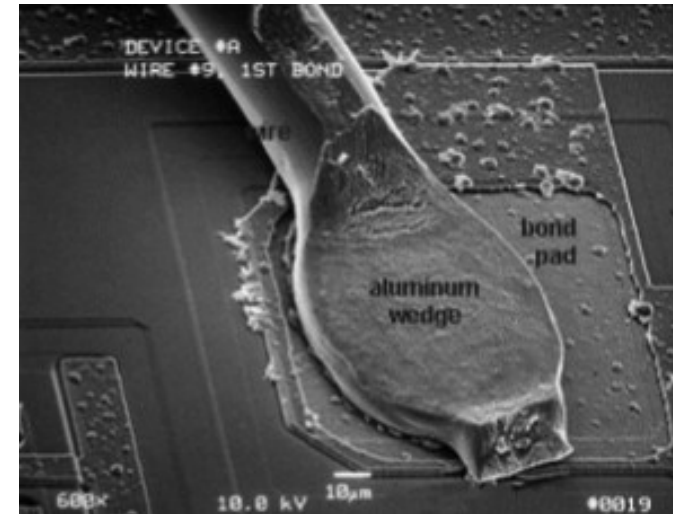
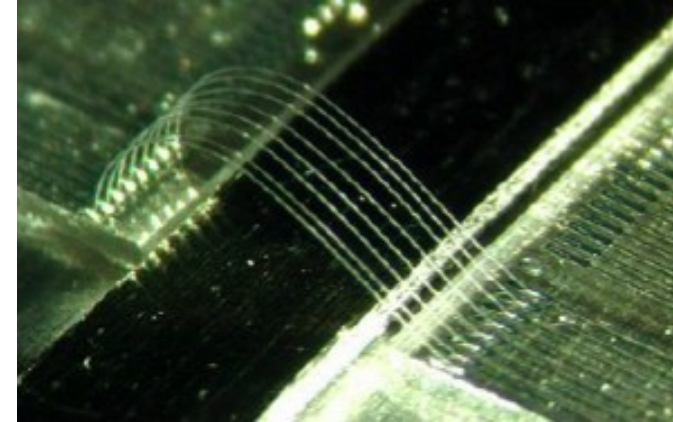
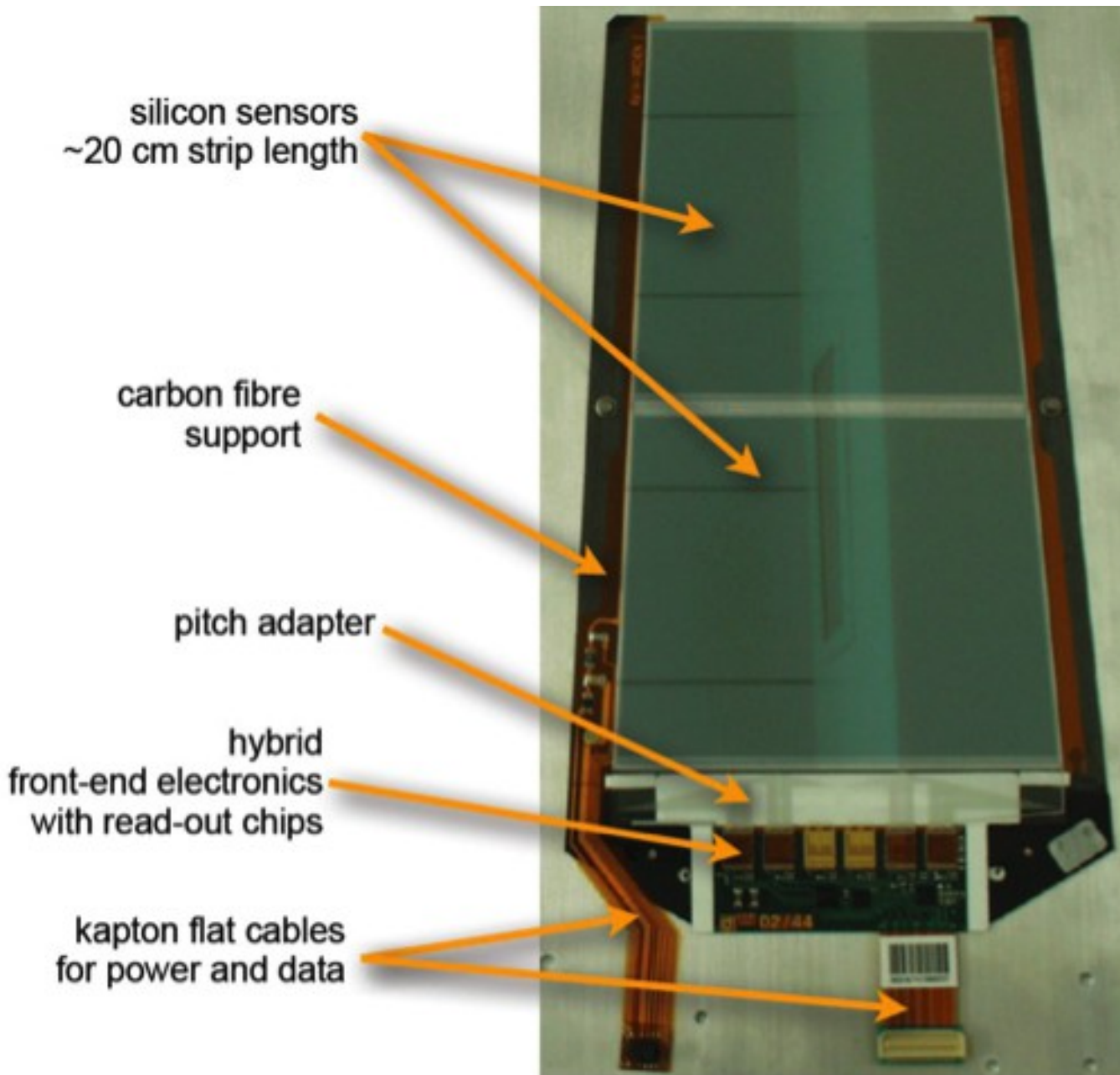
CMS strips

Optimizing S/N

- $N_{ADC} > \text{thr}$, given high granularity most channels are empty
- decrease noise terms (see above)
- minimize diffusion of charge cloud after thermal motion ▶
- (typically $\sim 8\mu\text{m}$ for $300\mu\text{m}$ drift)
- radiation damage severely affects S/N (next slide)



CMS module (strips)

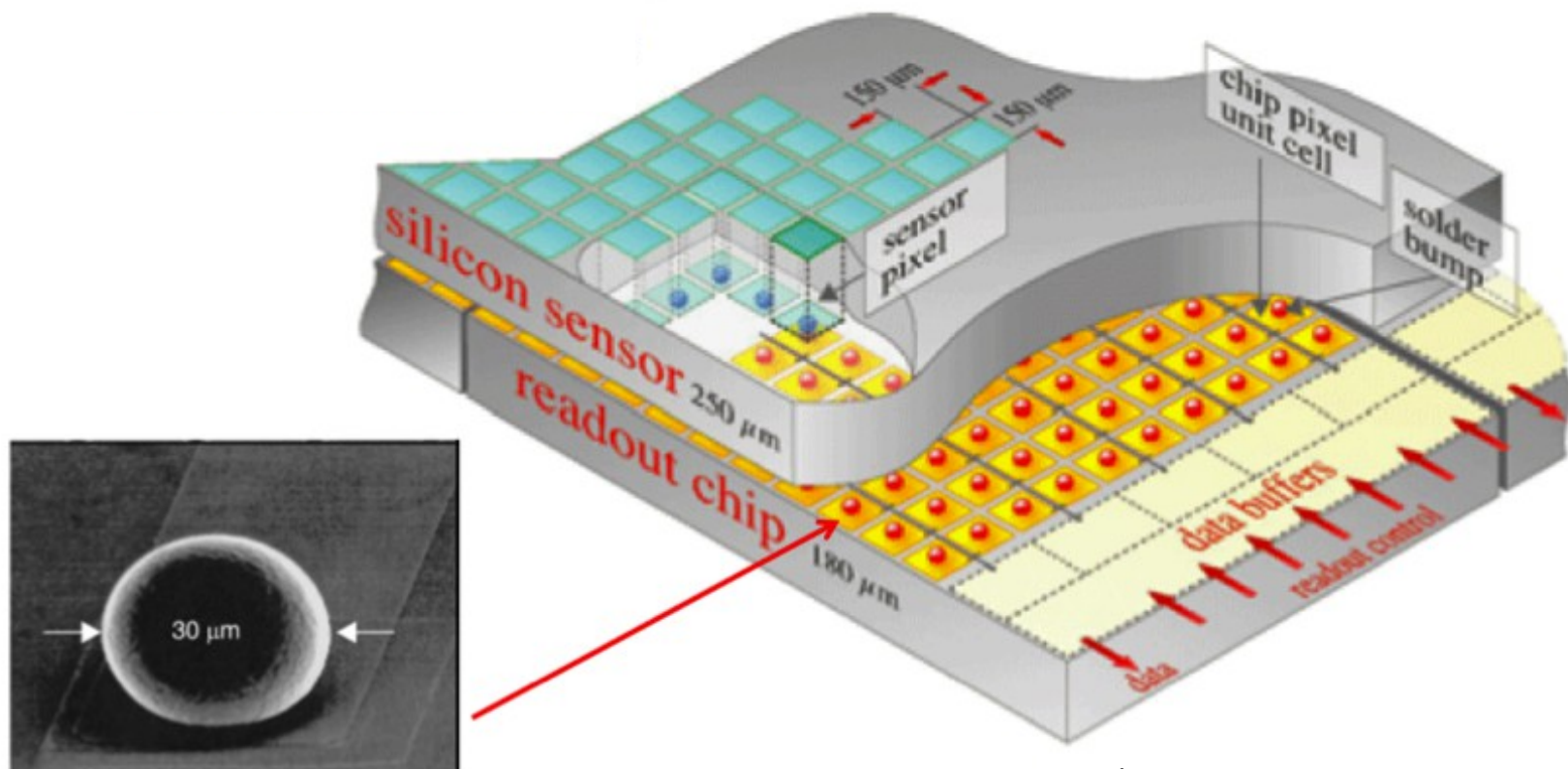


Pixel sensors

High track density better resolved with 2D position information

- back-to-back strips for 2D position information → yields “ghost” hits

Hybrid pixel detectors with sensors and bump-bonded readout chips



one sensor, 16 front-end chips and 1 master controller chip

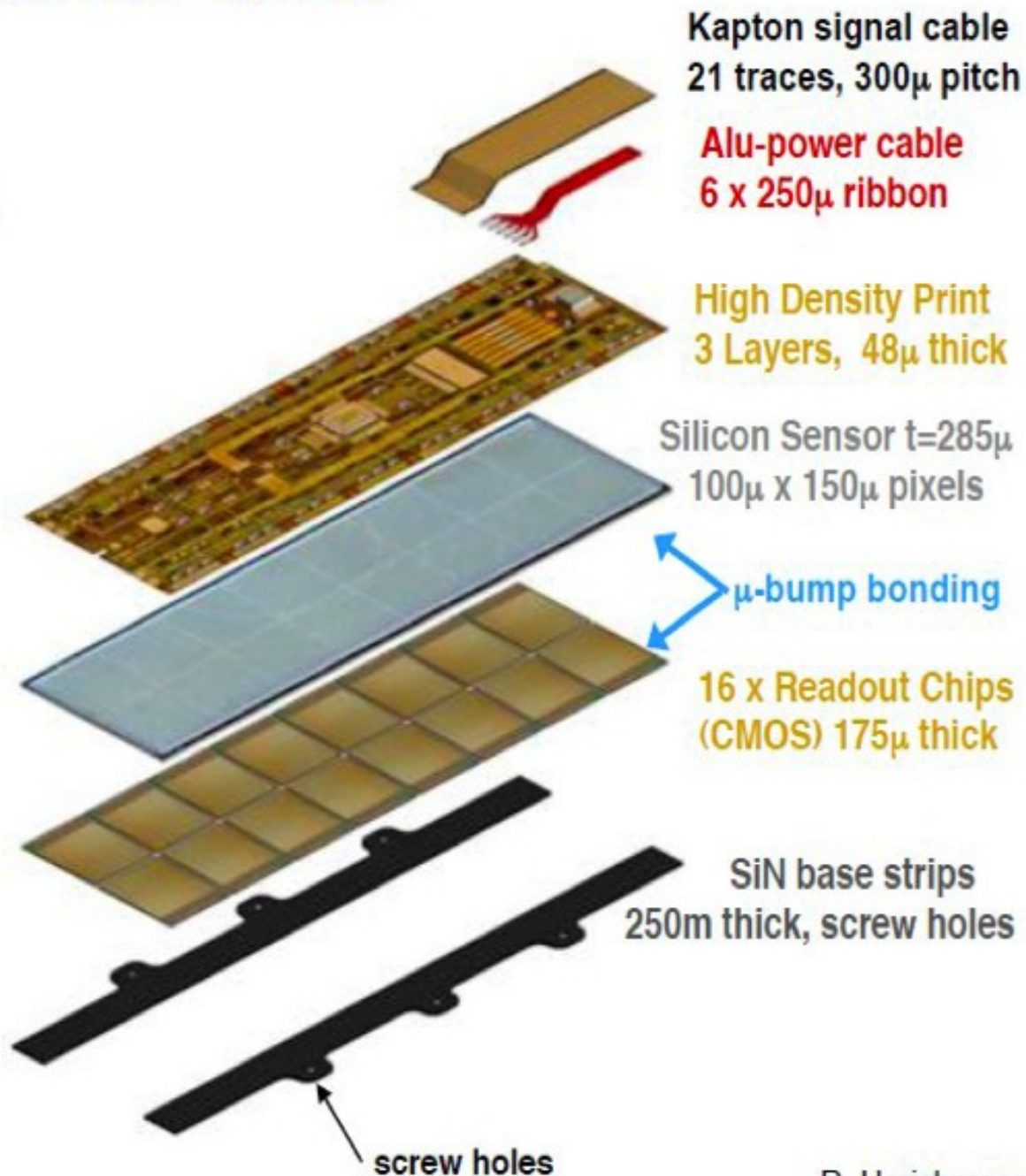
Hybrid Pixel Module for CMS

Sensor:

- Pixel Size: 150mm x 100mm
 - Resolution $\sigma_{r-\phi} \sim 15\mu\text{m}$
 - Resolution $\sigma_z \sim 20\mu\text{m}$
- n+-pixel on n-silicon design
 - Moderated p-spray \rightarrow HV robustness

Readout Chip:

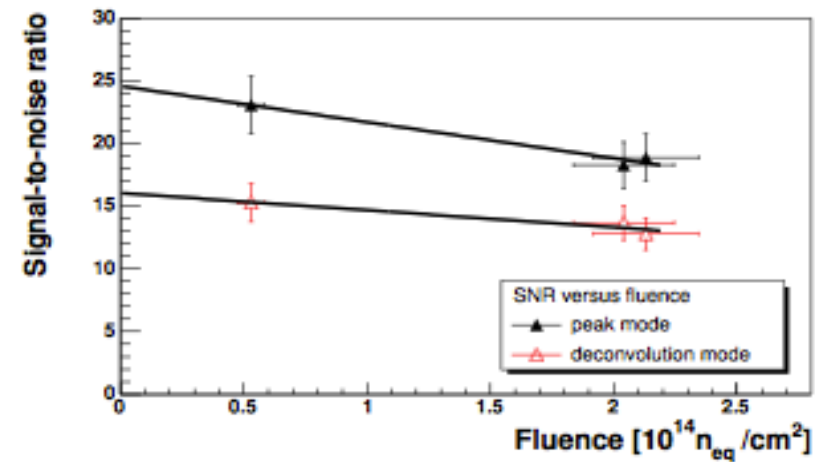
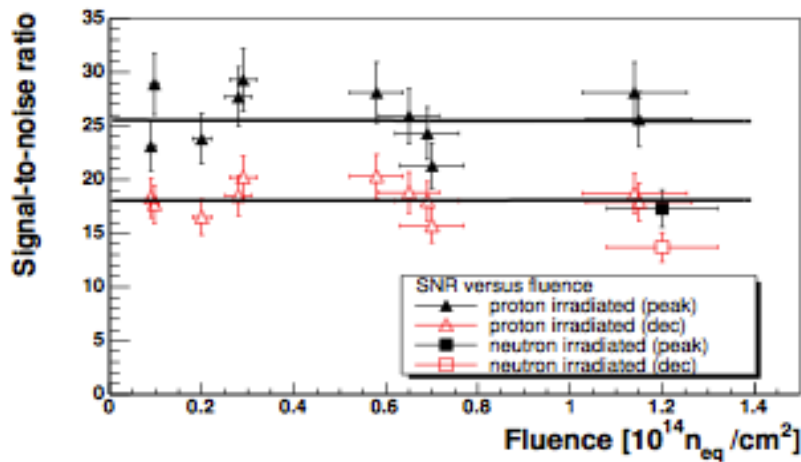
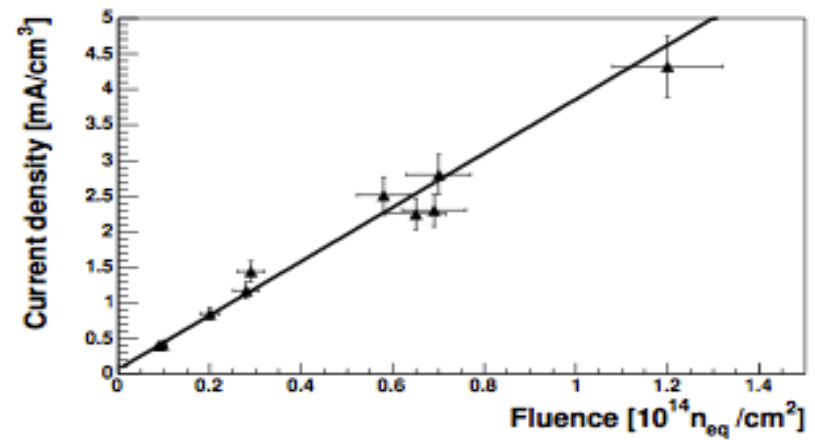
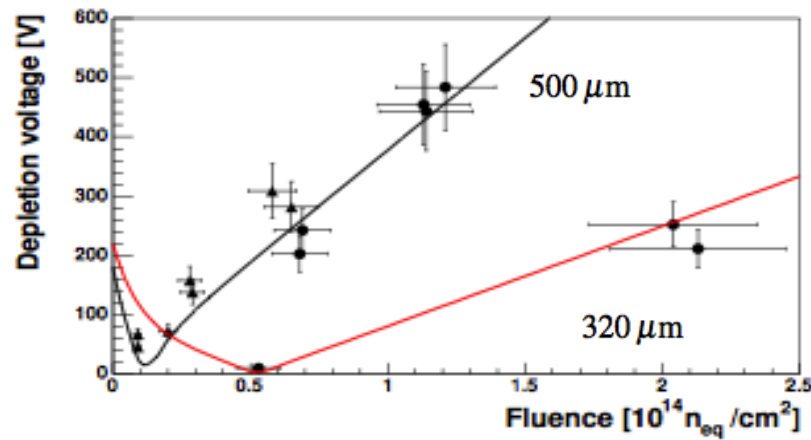
- Thinned to 175 μm
- 250nm CMOS IBM Process
- 8" Wafer

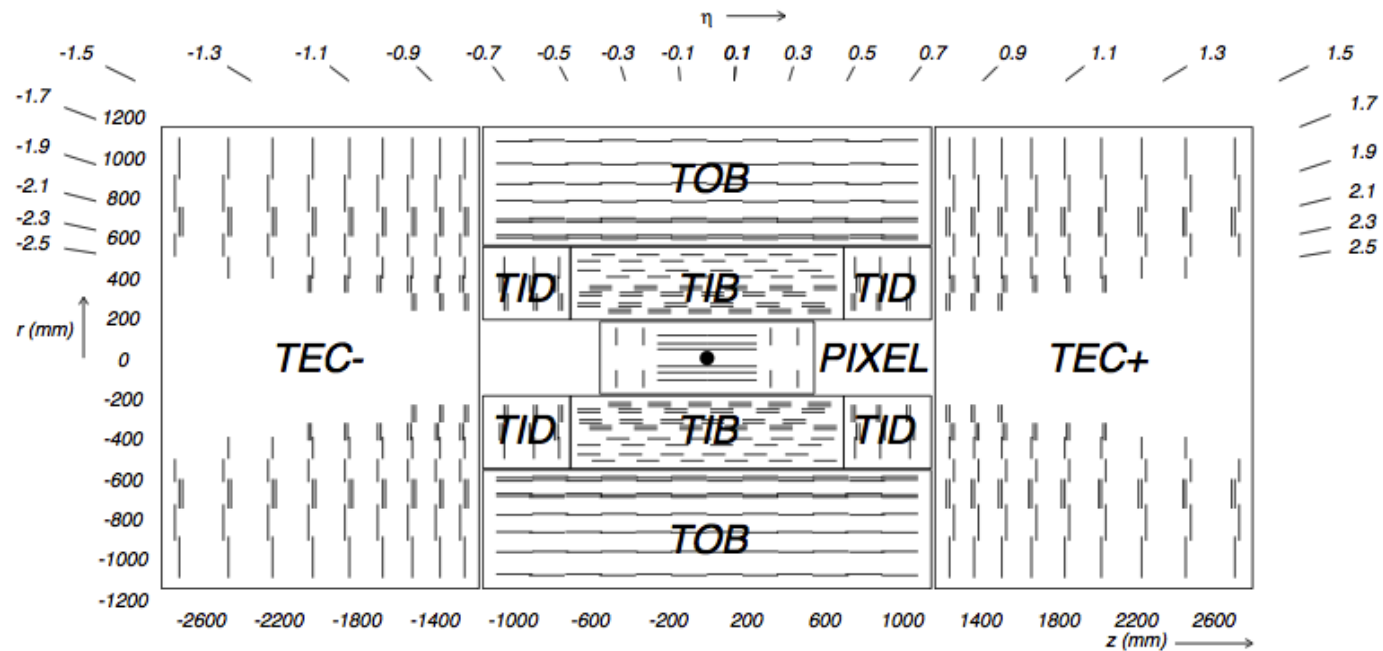


Influence of radiation

Si is not fully robust against radiation

- induced defects result in noise, inefficiency, leakage,...
- need to increase depletion voltage at higher fluences
- expected hit finding efficiency after 10 years of LHC operation: 95%



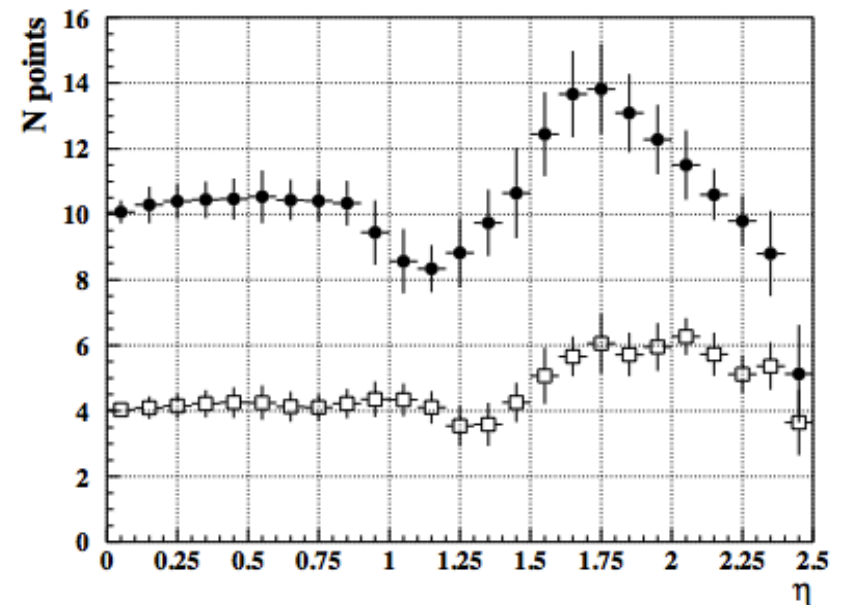


Pixel detector: $\sim 1\text{m}^2$ area

- 1.4k modules \Rightarrow 66M pixels

Strips: $\sim 200\text{m}^2$ area

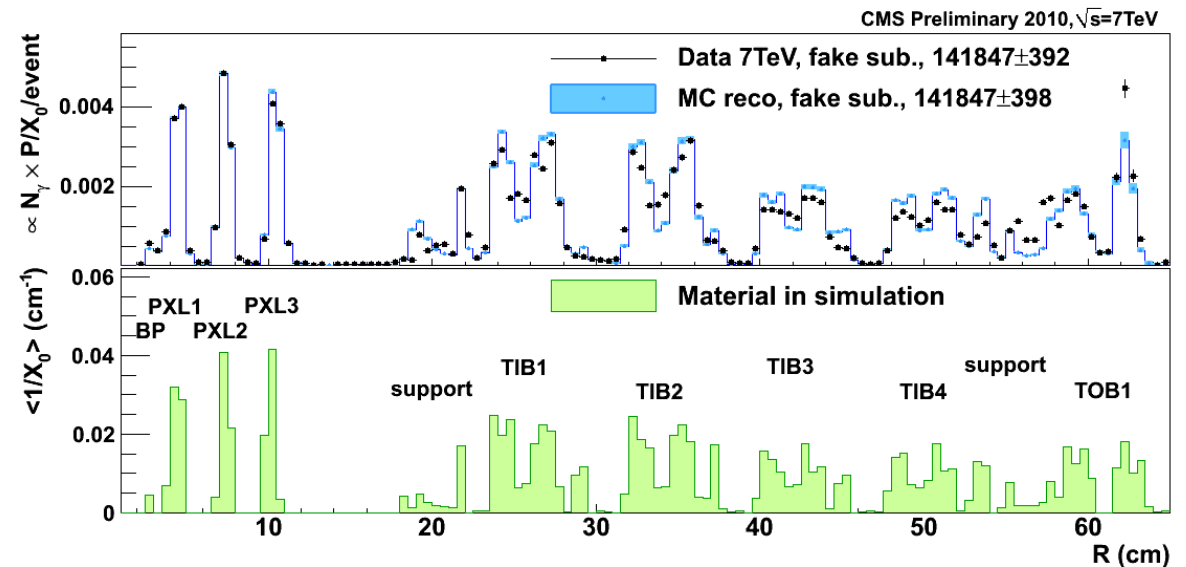
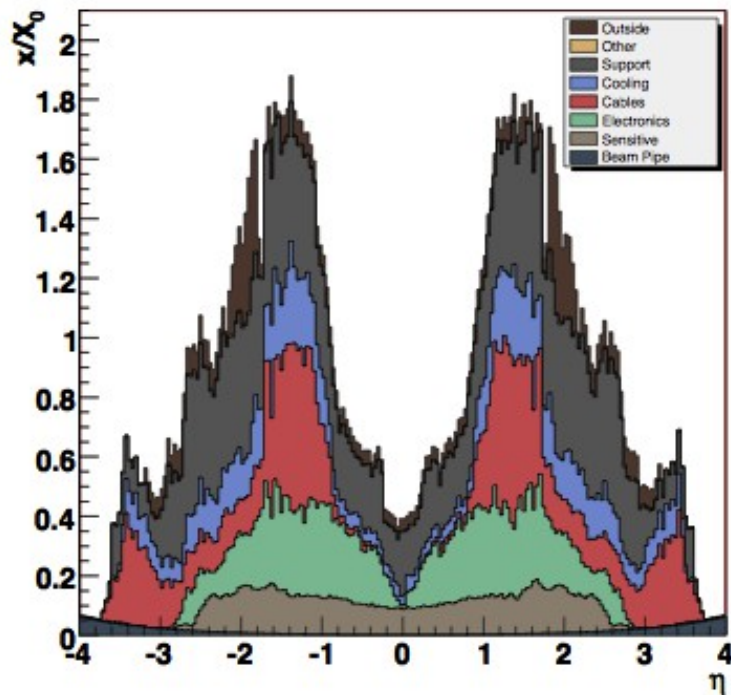
- 24k single sensors, 15k modules
- 9.6M strips = electronics channels
- 75k readout chips



CMS tracker budget

- In some regions can attain $1.8X_0$
 - often photons will convert, electrons will radiate :(
 - use for alignment and material budget estimation :)
- Precise knowledge is crucial, e.g. for Higgs with γ and electrons in the final state

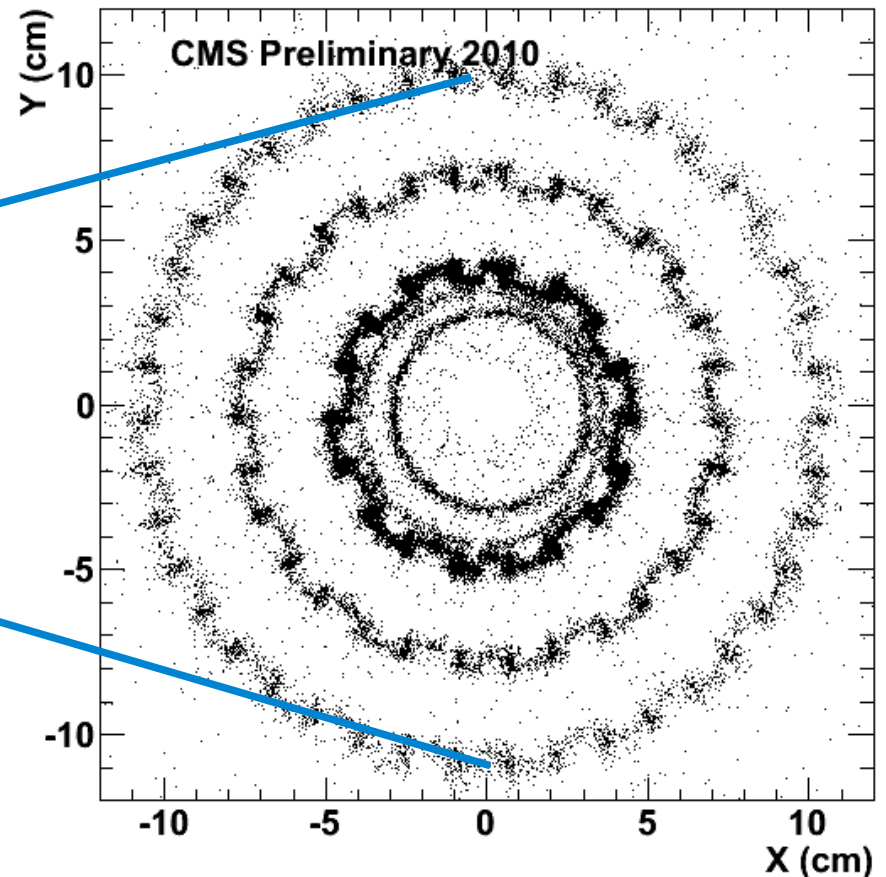
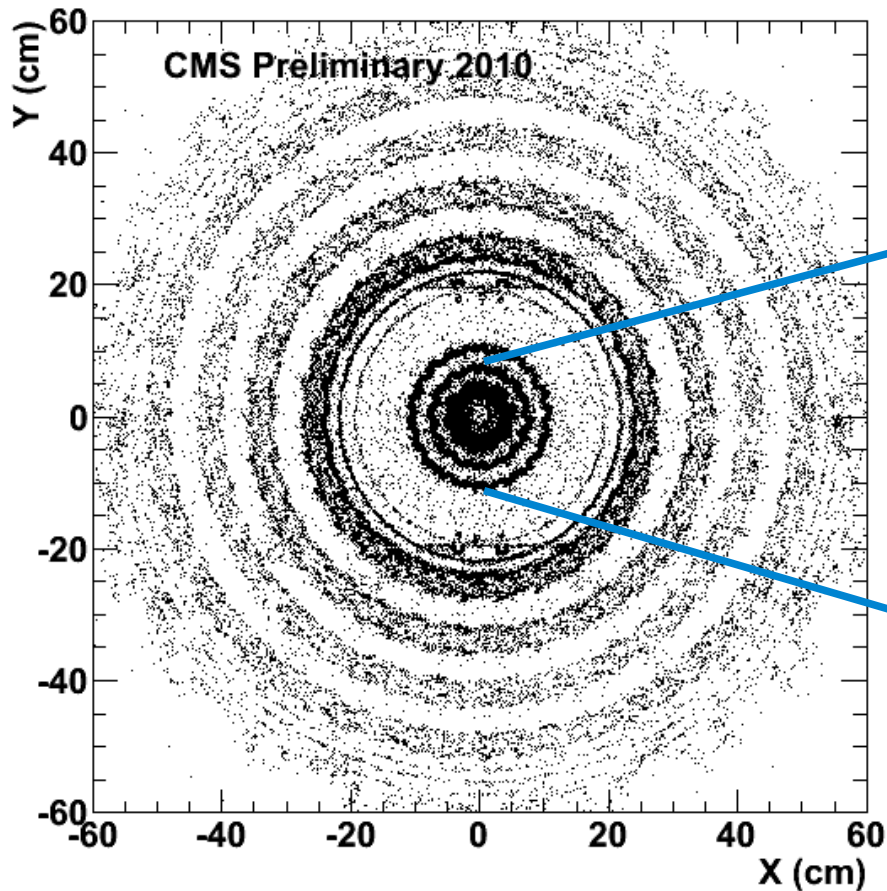
Tracker Material Budget



X-ray of the CMS tracker

Use photon conversions ($\gamma \rightarrow e^+e^-$)

- probability of interaction depends on the transversed material ($1-e^{-x/X_0}$)
- 54% of the $H \rightarrow \gamma\gamma$ events have are expected to have at least one conversion



Electrons

```

- 18py -- http://iguana.cern.ch/18py
Data recorded 1970-Jan-01 00:13:41 CDT
Run number    1
Event Number  667
Total section 666000
Orbit number   1
Beam position

```

```

L1 Triggers:
-----
L1_DoubleEG1
L1_DoubleEG5
L1_SingleEG1
L1_SingleEG2
L1_SingleEG5
L1_SingleIsoEG5
L1_SingleJetEG
L1_ZeroBias

```

They brem
Brem photons convert

Conversion tracks
collect secondary
electron clusters

Track momentum
change followed by
Gaussian Sum Filter

Brem clusters collected
by « track tangents »

